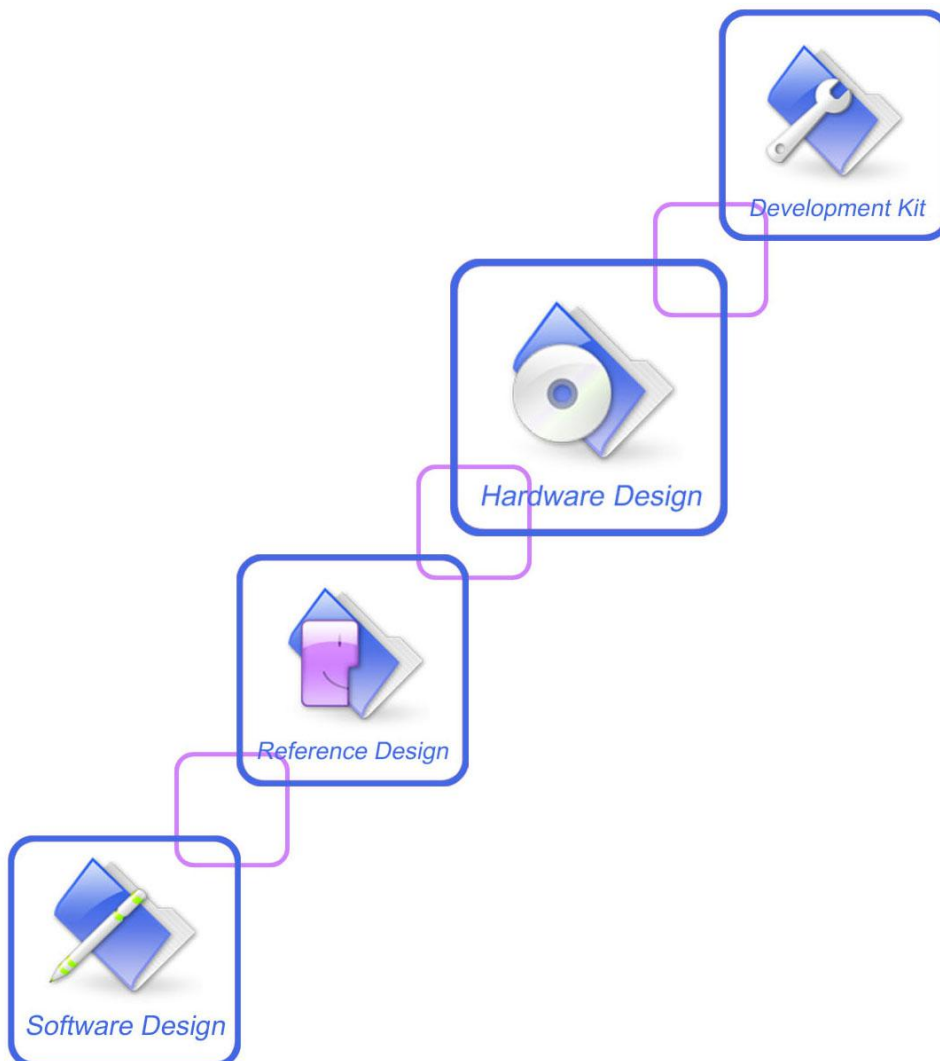




A company of SIM Tech

## **SIM7500x\_Hardware Design\_V1.00**



<b>Document Title</b>	SIM7500x Hardware Design
<b>Version</b>	V1.00
<b>Date</b>	2016-07-06
<b>Status</b>	Released
<b>Document Control ID</b>	SIM7500x_Hardware Design_V1.00

### General Notes

SIMCom offers this information as a service to its customers to support the application and engineering efforts that use the products designed by SIMCom. The information provided is based on the requirements specifically from the customers. SIMCom has not undertaken any independent search for additional relevant information, including any information that may be in the customer's possession. Furthermore, the system validation of the product designed by SIMCom within a larger electronic system remains the responsibility of the customer or the customer's system integrator. All specifications supplied herein are subject to change without notice.

### Copyright

This document contains the proprietary technical information which is the property of SIMCom Limited, copying of this document, giving it to others, the using or communication of the contents thereof are forbidden without the official authority by SIMCom. Offenders are liable to the payment of the damages. All rights are reserved in the event of grant of a patent or the registration of a utility model or design. All specifications supplied herein are subject to change without notice

*Copyright © SIMCom Wireless Solutions Co., Ltd. 2016*

## Contents

<b>Contents .....</b>	<b>3</b>
<b>Table Index .....</b>	<b>5</b>
<b>Figure Index .....</b>	<b>6</b>
<b>Revision History .....</b>	<b>7</b>
<b>1 Introduction.....</b>	<b>8</b>
1.1 Product Outline .....	8
1.2 Hardware Interface Overview .....	8
1.3 Hardware Block Diagram.....	9
1.4 Functional Overview .....	9
<b>2 Package Information .....</b>	<b>11</b>
2.1 Pin Assignment Overview .....	11
2.2 Pin Description .....	13
2.3 Mechanical Information .....	15
2.4 Footprint Recommendation .....	16
<b>3 Interface Application .....</b>	<b>17</b>
3.1 Power Supply .....	17
3.1.1 Power supply Design Guide .....	17
3.1.2 Recommended Power Supply Circuit .....	18
3.1.3 Voltage Monitor.....	19
3.2 Power on/Power off/Reset Function.....	19
3.2.1 Power on.....	19
3.2.2 Power off .....	20
3.2.3 Reset Function.....	21
3.3 UART Interface .....	22
3.3.1 UART Design Guide .....	22
3.3.2 RI and DTR Behavior.....	24
3.4 USB Interface.....	24
3.4.1 USB Application Guide.....	25
3.5 USIM Interface.....	25
3.5.1 USIM Application Guide.....	26
3.5.2 SIM Card Design Guide .....	26
3.5.3 Recommended USIM Card Holder .....	27
3.6 PCM Interface .....	28
3.6.1 PCM Timing.....	28
3.6.2 PCM Application Guide .....	29
3.7 I2C Interface .....	30
3.7.1 I2C Design Guide.....	30
3.8 Network Status .....	31
3.9 Operating Status Indication .....	31
3.10 Pin Multiplex Function .....	31
<b>SIM7500x_Hardware Design_V1.00</b>	<b>2016-07-06</b>

3.11	Other interface .....	32
3.11.1	Sink Current Source .....	32
3.11.2	ADC .....	33
<b>4</b>	<b>RF Specifications.....</b>	<b>34</b>
4.1	WCDMA/LTE RF Specifications .....	34
4.2	WCDMA/LTE Antenna Design Guide.....	35
<b>5</b>	<b>Electrical Specifications.....</b>	<b>37</b>
5.1	Absolute Maximum Ratings.....	37
5.2	Operating Conditions .....	37
5.3	Operating Mode .....	38
5.3.1	Operating Mode Definition .....	38
5.3.2	Sleep Mode.....	39
5.3.3	Minimum Functionality Mode and Flight Mode.....	39
5.4	Current Consumption .....	39
5.5	ESD Notes .....	40
<b>6</b>	<b>SMT Production Guide .....</b>	<b>42</b>
6.1	Top and Bottom View of SIM7500x .....	42
6.2	Label Information.....	43
6.3	Typical SMT Reflow Profile .....	43
6.4	Moisture Sensitivity Level (MSL) .....	44
6.5	Stencil Foil Design Recommendation.....	45
<b>7</b>	<b>Packaging.....</b>	<b>46</b>
<b>Appendix.....</b>		<b>48</b>
A.	Reference Design.....	48
B.	Coding Schemes and Maximum Net Data Rates over Air Interface.....	49
C.	Related Documents .....	51
D.	Terms and Abbreviations.....	53
E.	Safety Caution.....	55

## Table Index

Table 1: SIM7500x frequency bands .....	8
Table 2: General features .....	9
Table 3: Pin Definitions .....	12
Table 4: IO parameters definition.....	13
Table 6: VBAT Pins electronic characteristic.....	17
Table 7: Recommended zener diode list.....	18
Table 8: Power on timing and electronic characteristic.....	20
Table 9: Power off timing and Electronic Characteristic.....	21
Table 10: RESET pin electronic characteristic.....	22
Table 11: USIM Electronic characteristic in 1.8V mode (USIM_VDD=1.8V).....	25
Table 12: USIM Electronic characteristic 3.0V mode (USIM_VDD=2.95V).....	26
Table 13: Amphenol USIM Socket Pin Description.....	27
Table 15: PCM Timing Parameters .....	29
Table 16: NETLIGHT pin status.....	31
Table 17: Pin definition of the STATUS .....	31
Table 18: Pin multiplex function list .....	32
Table 19: Sink current electronic characteristic .....	32
Table 20: ADC Electronic Characteristics.....	33
Table 21: Conducted transmission power .....	34
Table 22: Operating frequencies .....	34
Table 23: Conducted receive sensitivity.....	34
Table 24: Reference sensitivity (QPSK) .....	35
Table 26: Recommended TVS .....	36
Table 27: Absolute maximum ratings.....	37
Table 28: Recommended operating ratings .....	37
Table 29: 1.8V Digital I/O characteristics* .....	37
Table 30: Operating temperature.....	38
Table 31: Operating mode Definitions .....	38
Table 33: The ESD performance measurement table (Temperature: 25℃, Humidity: 45%) .....	40
Table 34: The Description of Label Information.....	43
Table 35: Moisture Sensitivity Level and Floor Life .....	44
Table 36: Tray size .....	46
Table 37: Small Carton size .....	47
Table 38: Big carton size.....	47
Table 39: Coding schemes and maximum net data rates over air interface .....	49
Table 40: Related documents .....	51
Table 41: Terms and Abbreviations .....	53
Table 42: Safety caution.....	55

## Figure Index

Figure 1: SIM7500x Block Diagram.....	9
Figure 2: Pin assignment overview .....	11
Figure 3: Dimensions (Unit: mm) .....	15
Figure 5: Power supply application circuit.....	17
Figure 6: Linear regulator reference circuit .....	18
Figure 7: Switching mode power supply reference circuit.....	18
Figure 8: Reference Power on/off Circuit .....	19
Figure 9: Power on timing sequence .....	20
Figure 10: Power off timing sequence .....	21
Figure 11: Reference reset circuit .....	22
Figure 12: UART full modem .....	23
Figure 13: UART null Modem .....	23
Figure 14: Reference circuit of level shift.....	23
Figure 15: RI behaviour (SMS and URC report) .....	24
Figure 16: RI behaviour (voice call) .....	24
Figure 17: USB reference circuit .....	25
Figure 18: USIM interface reference circuit .....	26
Figure 19: Amphenol SIM card socket .....	27
Figure 20: PCM_SYNC timing.....	28
Figure 21: EXT codec to module timing.....	28
Figure 22: Module to EXT codec timing .....	29
Figure 23: Audio codec reference circuit .....	30
Figure 24: I2C reference circuit .....	30
Figure 25: NETLIGHT reference circuit.....	31
Figure 26: ISINK reference circuit .....	32
Figure 27: Antenna matching circuit (MAIN_ANT).....	35
Figure 28: Antenna matching circuit (DIV_ANT) .....	36
Figure 29: Top and bottom view of SIM7500x .....	42
Figure 30: Label Information.....	43
Figure 31: The ramp-soak-spike Reflow Profile of SIM7500x .....	44
Figure 32: Packaging introduce .....	46
Figure 33: Module tray drawing introduce.....	46
Figure 34: Small carton drawing introduce .....	47
Figure 35: Big carton drawing introduce .....	47
Figure 36: Reference design .....	48

## Revision History

Data	Version	Description of change	Author
2016-07-06	1.00	Original	Yuan Shijie Teng lili

SIMCOM CONFIDENTIAL FILE

# 1 Introduction

This document describes the electronic specifications, RF specifications, interfaces, mechanical characteristics and testing results of the SIMCom SIM7500x. With the help of this document and other SIM7500x software application notes/user guides, users can understand and use SIM7500x series modules to design and develop applications quickly.

## 1.1 Product Outline

The SIM7500x support many air-interface standards, refer to the following table.

**Table 1: SIM7500x frequency bands**

Standard	Frequency	SIM7500A	SIM7500JE
WCDMA	BAND2	✓	
	BAND5	✓	
LTE	LTE-FDD B1		✓
	LTE-FDD B2	✓	
	LTE-FDD B3		✓
	LTE-FDD B4	✓	
	LTE-FDD B8		✓
	LTE-FDD B17	✓	
Category		CAT1	CAT1
GNSS			✓

With a small physical dimension of 24\*27\*2.75 mm and with the functions integrated, the SIM7500x can meet almost any space requirement in users' applications, such as smart phones, PDA's, industrial handhelds, machine-to-machine, vehicle applications, etc.

## 1.2 Hardware Interface Overview

The interfaces that are described in detail in the next chapters include:

- **Power Supply**
- **USB Interface**
- **UART Interface**
- **USIM Interface**
- **GPIO**
- **ADC**
- **Power Output**
- **Current Sink Source**
- **PCM Interface**
- **I2C Interface**



### 1.3 Hardware Block Diagram

The block diagram of the SIM7500x is shown in the figure below.

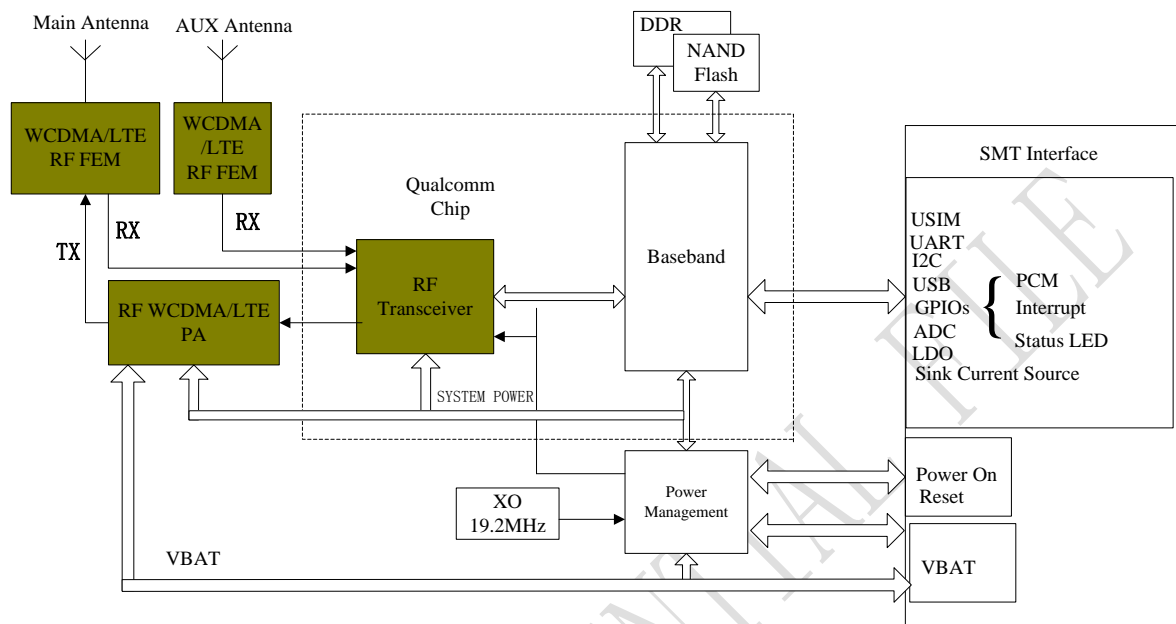


Figure 1: SIM7500x Block Diagram

### 1.4 Functional Overview

Table 2: General features

Feature	Implementation
Power supply	Single supply voltage 3.4~4.2V
Power saving	Current in sleep mode : <5mA
Radio frequency bands	Please refer to the table 1
Transmitting power	WCDMA: Class 3 (0.25W) LTE: Class 3 (0.25W)
Data Transmission Throughout	UMTS R99 speed: 384 kbps DL/UL HSPA+: 5.76 Mbps(UL), 42 Mbps(DL) LTE Category 1: 10 Mbps (DL) LTE Category 1: 5 Mbps (UL)
Antenna	WCDMA /LTE main antenna. WCDMA /LTE auxiliary antenna.
SMS	MT, MO, CB, Text and PDU mode SMS storage: USIM card or ME(default) Transmission of SMS alternatively over CS or PS.
USIM interface	Support identity card: 1.8V/ 3V

USIM application toolkit	Support SAT class 3, GSM 11.14 Release 98 Support USAT
Phonebook management	Support phonebook types: DC,MC,RC,SM,ME,FD,ON,LD,EN
Audio feature	Support PCM interface Only support PCM master mode and short frame sync, 16-bit linear data formats
UART interface	A full modem serial port by default Baud rate: 300bps to 4Mbps(default:115200bps) Auto-bauding baud rate: 9600,19200,38400,57600,115200bps Can be used as the AT commands or data stream channel. Support RTS/CTS hardware handshake Multiplex ability according to GSM 07.10 Multiplexer Protocol.
USB	USB 2.0 specification-compliant as a peripheral
Firmware upgrade USB	Firmware upgrade over USB interface USB 2.0 specification-compliant as a peripheral
Physical characteristics	Weight:4.0 g Size:24*27*2.75mm
Temperature range	Normal operation temperature: -30 ℃ to +80 ℃ Extended operation temperature: -40 ℃ to +85 ℃* Storage temperature -45 ℃ to +90 ℃

**\*Note: Module is able to make and receive voice calls, data calls, SMS and make WCDMA/HSPA+/LTE traffic in -40℃ ~ +85℃. The performance will be reduced slightly from the 3GPP specifications if the temperature is outside the normal operating temperature range and still within the extreme operating temperature range.**

## 2 Package Information

### 2.1 Pin Assignment Overview

All functions of the SIM7500x will be provided through 56 pads that will be connected to the customers' platform. The following Figure is a high-level view of the pin assignment of the SIM7500x.

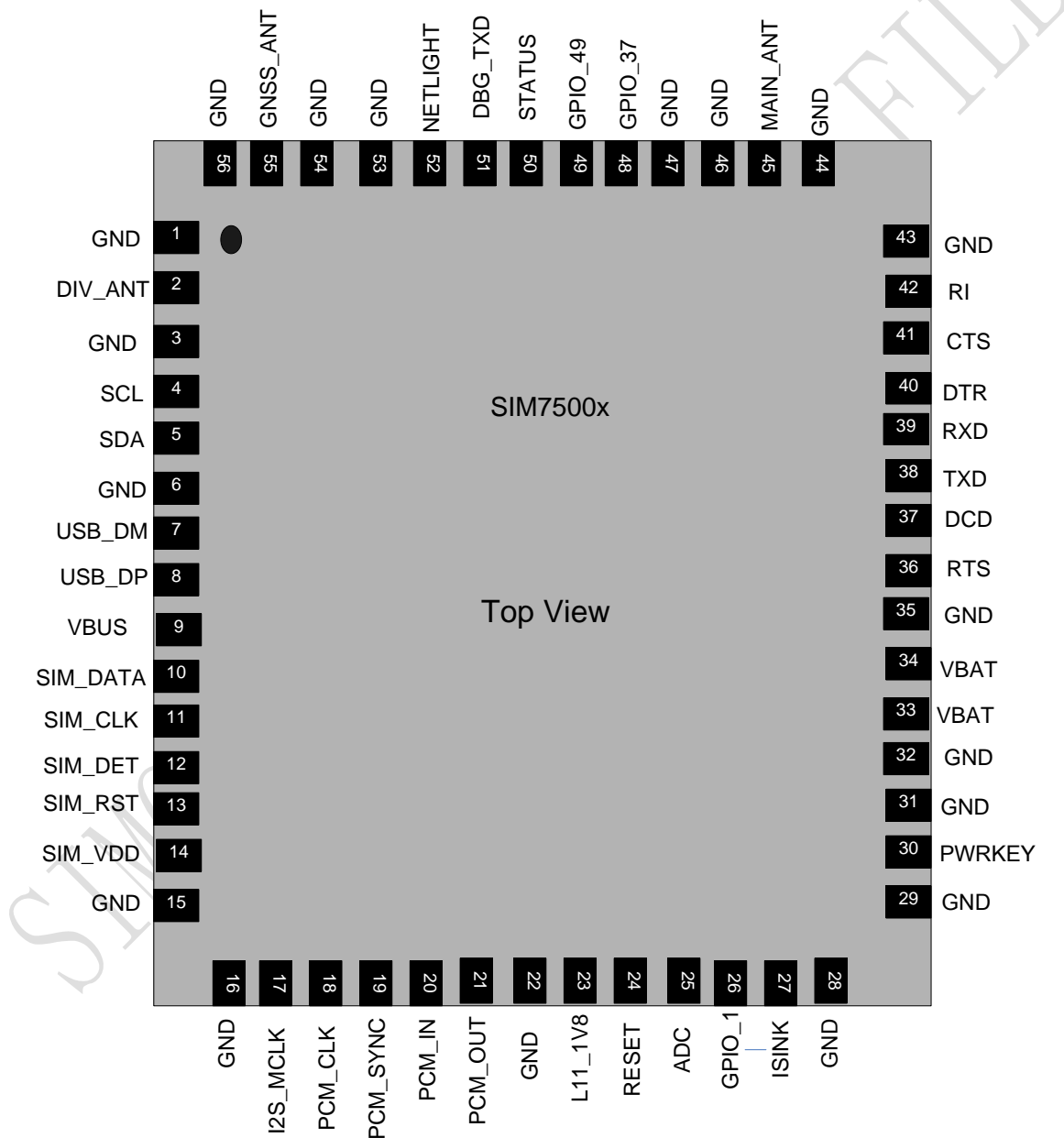


Figure 2: Pin assignment overview

**Table 3: Pin Definitions**

Pin No.	Pin Name	Pin No.	Pin Name
1	GND	2	DIV_ANT
3	GND	4	SCL
5	SDA	6	GND
7	USB_DM	8	USB_DP
9	VBUS	10	USIM_DATA
11	USIM_CLK	12	USIM_DET
13	USIM_RST	14	USIM_VDD
15	GND	16	GND
17	MCLK	18	PCM_CLK
19	PCM_SYNC	20	PCM_IN
21	PCM_OUT	22	GND
23	L11_1V8	24	RESET
25	ADC	26	GPIO_1
27	ISINK	28	GND
29	GND	30	PWRKEY
31	GND	32	GND
33	VBAT	34	VBAT
35	GND	36	RTS
37	DCD	38	TXD
39	RXD	40	DTR
41	CTS	42	RI
43	GND	44	GND
45	MAIN_ANT	46	GND
47	GND	48*	GPIO_37
49	GPIO_49	50	STATUS
51	DBG_TXD	52	NETLIGHT
53	GND	54	GND
55	RESERVED	56	GND

*\*Note: Module will be forced into USB download mode by connecting pin48 to L11\_1V8 during power up. After using download mode, please keep the pin48 open.*

## 2.2 Pin Description

**Table 4: IO parameters definition**

Pin type	Description
PI	Power input
PO	Power output
AI	Analog input
AIO	Analog input/output
I/O	Bidirectional input /output
DI	Digital input
DO	Digital output
DOH	Digital output with high level
DOL	Digital output with low level
PU	Pull up
PD	Pull down

**Table 5: Pin description**

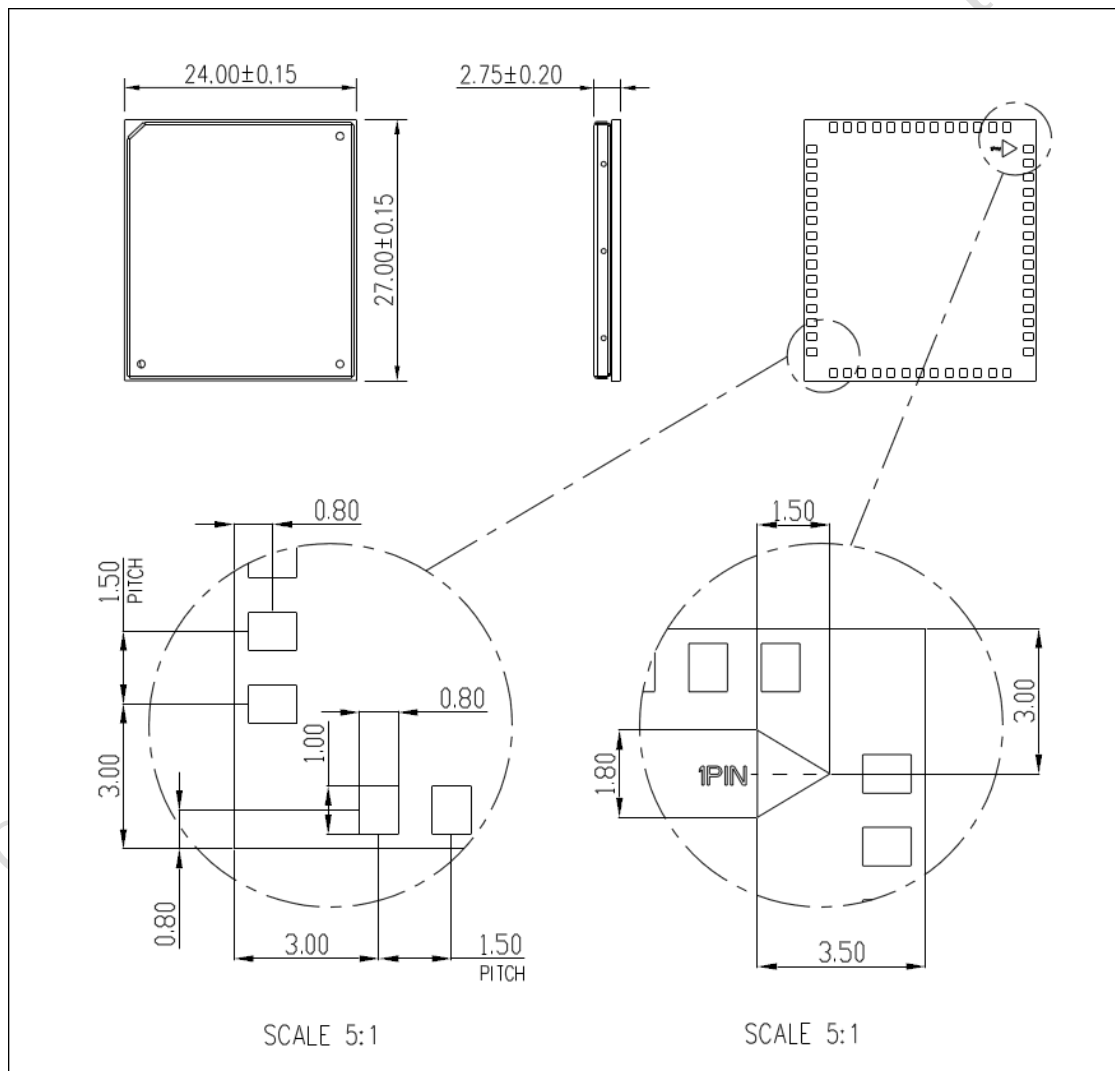
Pin name	Pin No.	Default status	Description	Comment
<b>Power Supply</b>				
VBAT	33,34	PI	Power supply, voltage range: 3.4~4.2V.	
L11_1V8	23	PO	1.8V output with Max. 50mA current output for external circuit, such as level shift circuit.	If unused, keep it open.
GND	1, 3, 6, 15,16,22,28,29,31,32,35,43,44,46,47,53,54,56		Ground	
<b>System Control</b>				
PWRKEY	30	DI,PU	System power on/off control input, active low.	default 0.8V
RESET	24	DI, PU	System reset control input, active low.	RESET has been pulled up to 1.8V via a resistor internally.
<b>USIM interface</b>				
USIM_DATA	10	I/O,PU	USIM Card data I/O, which has been pulled up via a 100KR resistor to USIM_VDD internally.	All lines of USIM interface should be protected against ESD.
USIM_RST	13	DO	USIM Reset	

USIM_CLK	11	DO	USIM clock	
USIM_VDD	14	PO	Power output for USIM card, its output Voltage depends on USIM card type automatically. Its output current is up to 50mA.	
USB				
VBUS	9	DI,PD	Valid USB detection input with 3.6~5.85V detection voltage	
USB_DM	7	I/O	Negative line of the differential, bi-directional USB signal.	
USB_DP	8	I/O	Positive line of the differential, bi-directional USB signal.	
UART interface				
RTS	36	DOH	Request to send	If unused, keep them open.
CTS	41	DI,PU	Clear to Send	
RXD	39	DI,PU	Receive Data	
RI	42	DOH	Ring Indicator	
DCD	37	DOH	Carrier detects	
TXD	38	DOH	Transmit Data	
DTR	40	DI,PU	DTE get ready	
I2C interface				
SCL	4	DO	I2C clock output	If unused, keep them open.
SDA	5	I/O	I2C data input/output	
PCM interface				
PCM_OUT	21	DO	PCM data output.	If unused, please keep them open.
PCM_IN	20	DI	PCM data input.	
PCM_SYNC	19	DO	PCM data frame sync signal.	
PCM_CLK	18	DO	PCM data bit clock.	
MCLK	17	DO	Audio Master clock	
GPIO				
NETLIGHT	52	DO	LED control output as network status indication.	If unused, please keep them open.
STATUS	50	DO	Operating status output. High level: Power on and firmware ready Low level: Power off	
GPIO_1	26	IO	GPIO	
GPIO_49	49	IO	GPIO	
USIM_DET	12	IO	Default: GPIO Optional: USIM card detecting input. H: USIM is removed L: USIM is inserted	
GPIO_37	48	IO	GPIO	

RF interface				
MAIN_ANT	45	AIO	MAIN antenna soldering pad	
DIV_ANT	2	AI	Auxiliary antenna soldering pad	
Other interface				
ISINK	27	AI	Ground-referenced current sink.	If unused, please keep them open.
DGB_TXD	51	DO	Use for debug	
ADC	25	AI	Analog-digital converter input	

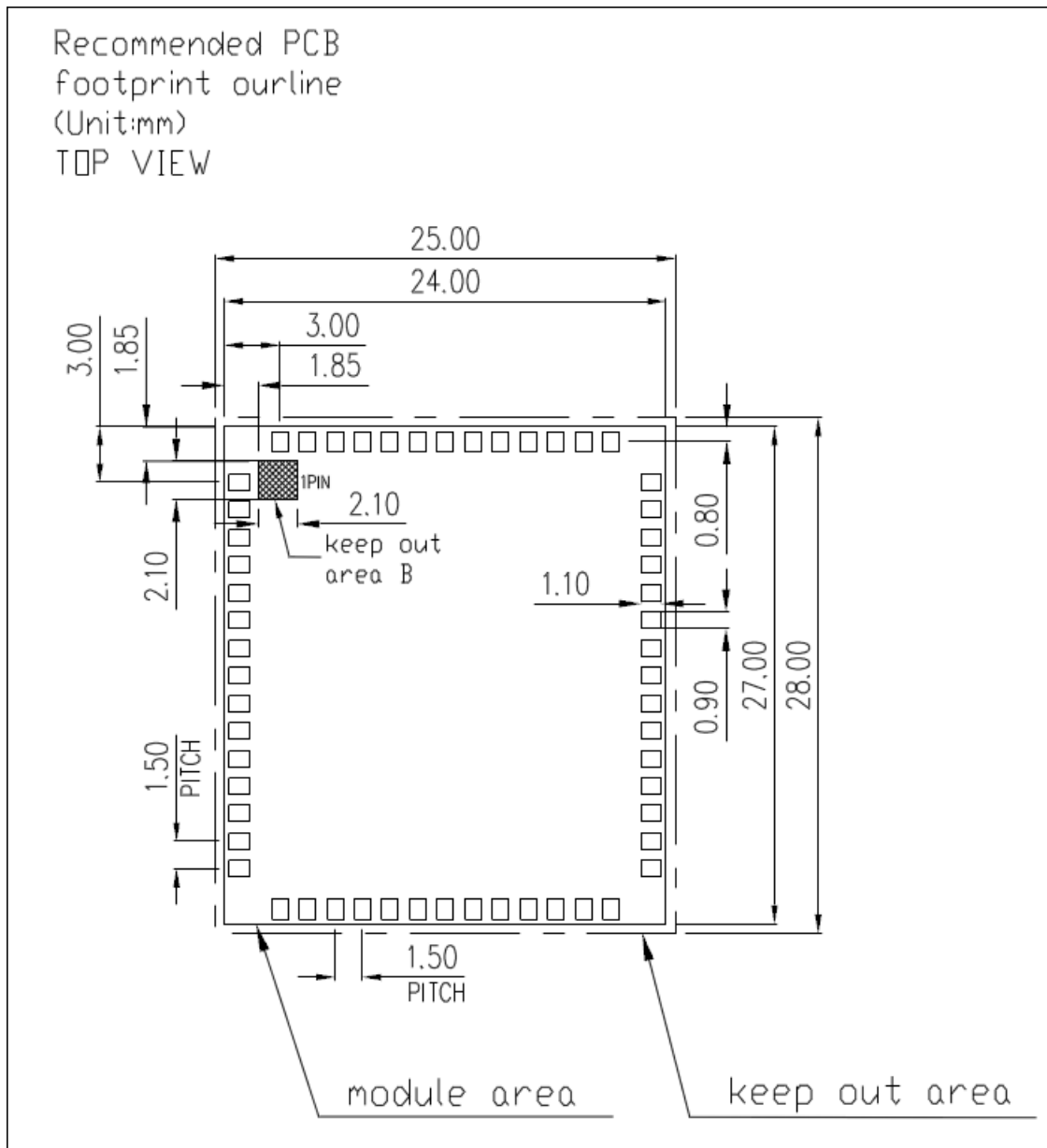
## 2.3 Mechanical Information

The following figure shows the package outline drawing of SIM7500x.



**Figure 3: Dimensions (Unit: mm)**

## 2.4 Footprint Recommendation



**Figure 4: Footprint recommendation (Unit: mm)**



## 3 Interface Application

### 3.1 Power Supply

On VBAT pads, a ripple current up to 1.5A typically, may cause voltage drop. Therefore, the power supply for these pads must be able to provide sufficient current up to more than 1.5A in order to avoid the voltage drop of more than 300mV.

**Table 6: VBAT Pins electronic characteristic**

Symbol	Description	Min.	Typ.	Max.	Unit
VBAT	Module power voltage	3.4	3.8	4.2	V
I <sub>VBAT(peak)</sub>	Module power peak current in normal mode.	1.0	-	1.5	A
I <sub>VBAT(average)</sub>	Module power average current in normal mode	Please refer to the table 34			
I <sub>VBAT(sleep)</sub>	Power supply current in sleep mode				
I <sub>VBAT(power-off)</sub>	Module power current in power off mode.	-	-	20	uA

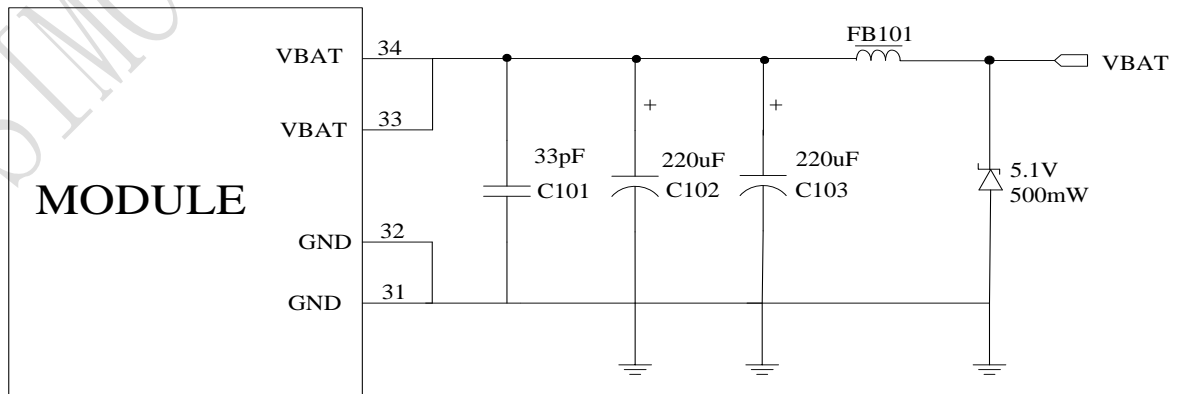
#### 3.1.1 Power supply Design Guide

Make sure that the voltage on the VBAT pins will never drop below 3.4V.

**Note:** If the power supply for BAT pins can support up to 1.5A, using a total of more than 330uF capacitors is recommended, or else users must use a total of 1000uF capacitors, in order to avoid the voltage drop of more than 300mV.

Some multi-layer ceramic chip (MLCC) capacitors (0.1/1uF) with low ESR in high frequency band can be used for EMC.

These capacitors should be put as close as possible to VBAT pads. Also, user should keep VBAT trace on the circuit board wider than 2 mm to minimize PCB trace impedance. The following figure shows the recommended circuit.



**Figure 5: Power supply application circuit**

In addition, in order to guard over voltage protection, it is suggested to use a zener diode with 5.1V reverse zener voltage and more than 500mW power dissipation.

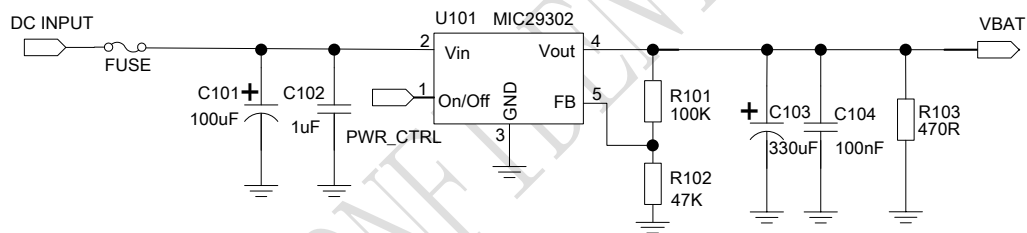
**Table 7: Recommended zener diode list**

No.	Manufacturer	Part Number	power dissipation	Package
1	On semi	MMSZ5231BT1G	500mW	SOD123
2	Prisemi	PZ3D4V2H	500mW	SOD323
3	Vishay	MMSZ4689-V	500mW	SOD123
4	Crownpo	CDZ55C5V1SM	500mW	0805

### 3.1.2 Recommended Power Supply Circuit

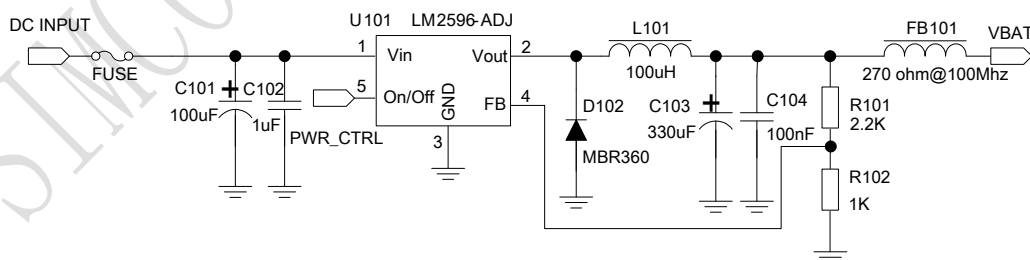
It is recommended that a switching mode power supply or linear regulator power supply is used. It is important to make sure that all the components used in the power supply circuit can resist a peak current up to 1.5A.

The following figure shows the linear regulator reference circuit with 5V input and 3.8V output.



**Figure 6: Linear regulator reference circuit**

If there is a big voltage difference between input and output for VBAT power supply, or the efficiency is extremely important, then a switching mode power supply will be preferable. The following figure shows the switching mode power supply reference circuit.



**Figure 7: Switching mode power supply reference circuit**

**Note:** The Switching Mode power supply solution for VBAT must be chosen carefully against Electro Magnetic Interference and ripple current from depraving RF performance.

### 3.1.3 Voltage Monitor

To monitor the VBAT voltage, the AT command “AT+CBC” can be used.

For monitoring the VBAT voltage outside or within a special range, the AT command “AT+CVALARM” can be used to enable the under-voltage warning function.

If users need to power off SIM7500x, when the VBAT voltage is out of a range, the AT command “AT+CPMVT” can be used to enable under-voltage power-off function.

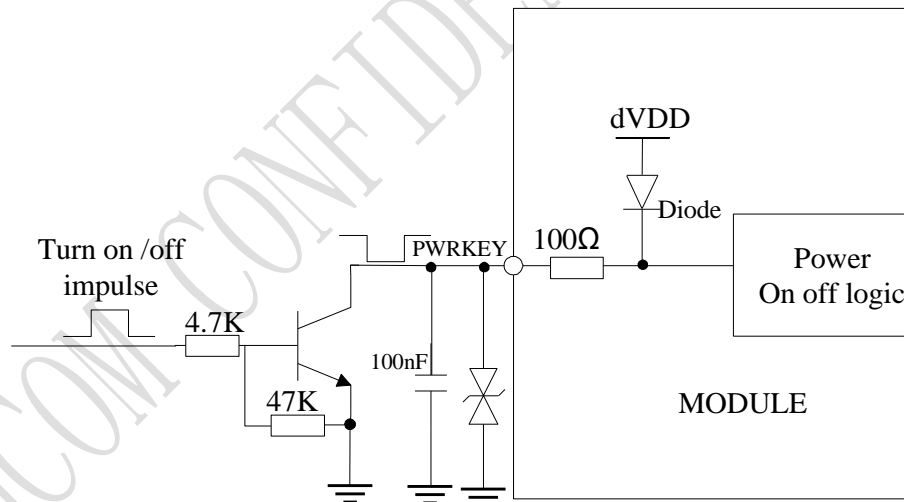
**Note:** Under-voltage warning function and under-voltage power-off function are disabled by default. For more information about these AT commands, please refer to Document [1].

## 3.2 Power on/Power off/Reset Function

### 3.2.1 Power on

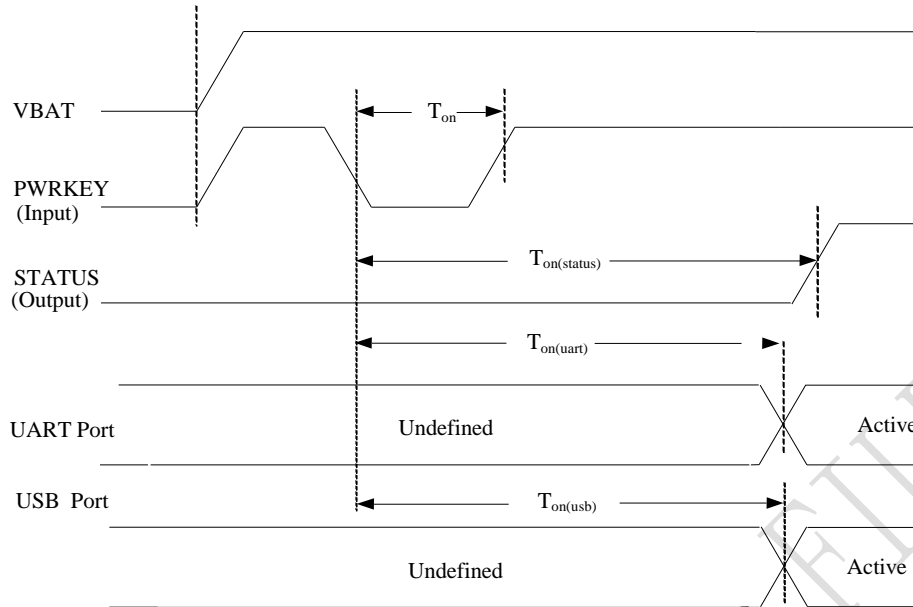
SIM7500x can be powered on by pulling the PWRKEY pin down to ground.

The PWRKEY pin has been pulled up to dVDD internally, so you does not need to pull it up externally. It is strongly recommended to put a 100nF capacitor and an ESD protection diode close to the PWRKEY pin. Please refer to the following figure for the recommended reference circuit.



**Figure 8: Reference Power on/off Circuit**

The power-on scenarios are illustrated in the following figure.



**Figure 9: Power on timing sequence**

**Table 8: Power on timing and electronic characteristic**

Symbol	Parameter	Min.	Typ.	Max.	Unit
$T_{on}$	The time of active low level impulse of PWRKEY pin to power on module	100	500	-	ms
$T_{on(status)}$	The time from power-on issue to STATUS pin output high level(indicating power up ready )	22	-	-	s
$T_{on(uart)}$	The time from power-on issue to UART port ready		20		s
$T_{on(usb)}$	The time from power-on issue to USB port ready		20		s
$V_{IH}$	Input high level voltage on PWRKEY pin	0.6	0.8	1.8	V
$V_{IL}$	Input low level voltage on PWRKEY pin	-0.3	0	0.5	V

### 3.2.2 Power off

The following methods can be used to power off SIM7500x.

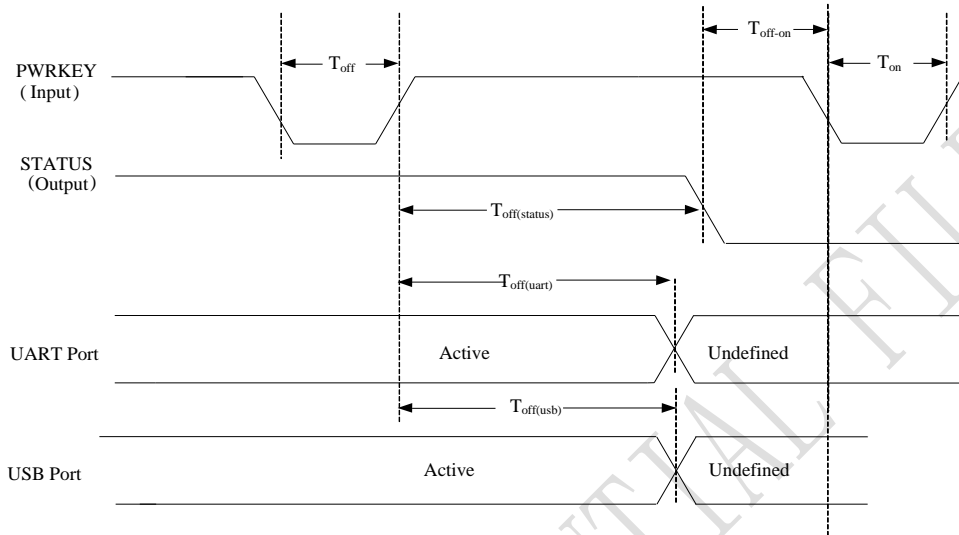
- Method 1: Power off SIM7500x by pulling the PWRKEY pin down to ground.
- Method 2: Power off SIM7500x by AT command “AT+CPOF”.
- Method 3: Over-voltage or under-voltage automatic power off. The voltage range can be set by AT command “AT+CPMVT”.
- Method 4: Over-temperature or under-temperature automatic power off.

**Note:** If the temperature is outside the range of -30~+80 ℃, some warning will be reported via AT port. If the temperature is outside the range of -40~+85 ℃, SIM7500x will be powered off automatically.

*For details about “AT+CPOF” and “AT+CPMVT”, please refer to Document [1].*

These procedures will make modules disconnect from the network and allow the software to enter a safe state and save data before modules are powered off completely.

The power off scenario by pulling down the PWRKEY pin is illustrated in the following figure.



**Figure 10: Power off timing sequence**

**Table 9: Power off timing and Electronic Characteristic**

Symbol	Parameter	Time value			Unit
		Min.	Typ.	Max.	
$T_{off}$	The active low level time pulse on PWRKEY pin to power off module	2.5	--	--	s
$T_{off(status)}$	The time from power-off issue to STATUS pin output low level(indicating power off )*	22	-	-	s
$T_{off(uart)}$	The time from power-off issue to UART port off	15	-	-	s
$T_{off(usb)}$	The time from power-off issue to USB port off	15	-	-	s
$T_{off-on}$	The buffer time from power-off issue to power-on issue	0	-	-	s

### 3.2.3 Reset Function

SIM7500x can be reset by pulling the RESET pin down to ground.

*Note: This function is only used as an emergency reset when AT command “AT+CPOF” and the PWRKEY pin all have lost efficacy.*

The RESET pin has been pulled up to 1.8V internally, so it does not need to be pulled up externally. It is strongly recommended to put a 100nF capacitor and an ESD protection diode close to the RESET pin. Please refer to the following figure for the recommended reference circuit.

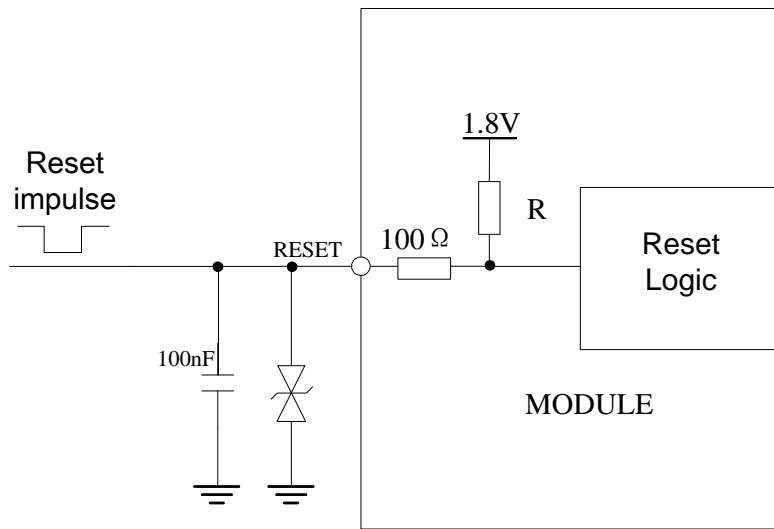


Figure 11: Reference reset circuit

Table 10: RESET pin electronic characteristic

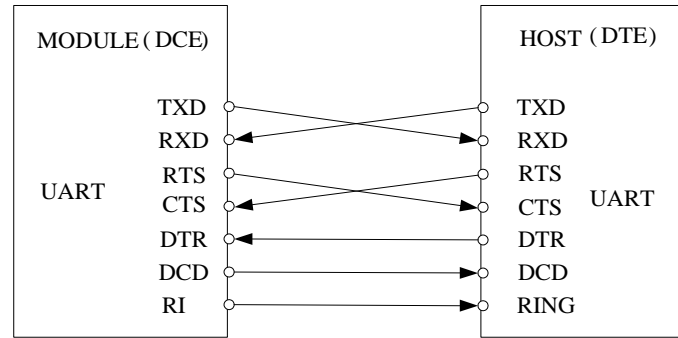
Symbol	Description	Min.	Typ.	Max.	Unit
$T_{reset}$	The active low level time impulse on RESET pin to reset module	100			ms
$V_{IH}$	Input high level voltage	1.17	1.8	2.1	V
$V_{IL}$	Input low level voltage	-0.3	0	0.8	V

### 3.3 UART Interface

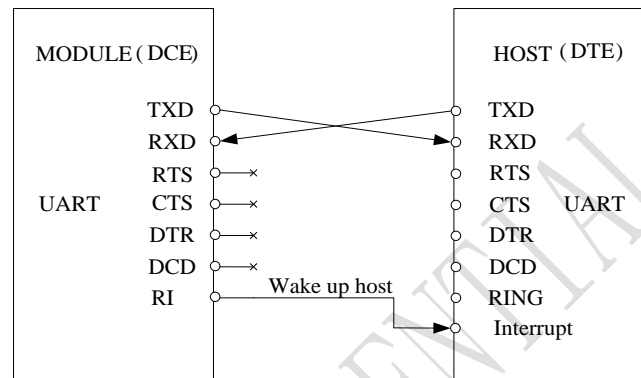
SIM7500x provides a 7-wire UART (universal asynchronous serial transmission) interface as DCE (Data Communication Equipment). AT commands and data transmission can be performed through UART interface.

#### 3.3.1 UART Design Guide

The following figures show the reference design.

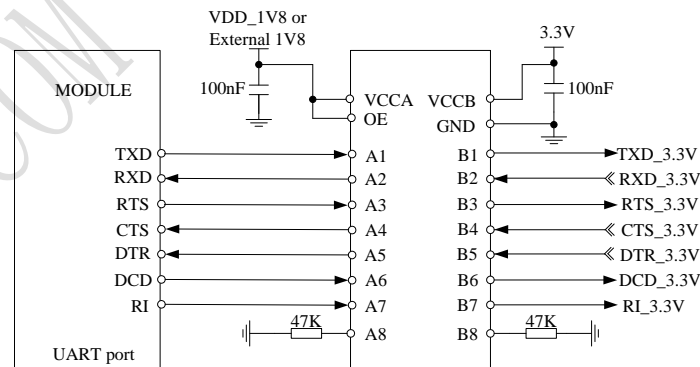


**Figure 12: UART full modem**



**Figure 13: UART null Modem**

The SIM7500x UART is 1.8V voltage interface. If user's UART application circuit is a 3.3V voltage interface, the level shifter circuits should be used for voltage matching. The TXB0108RGYR provided by Texas Instruments is recommended. The following figure shows the voltage matching reference design.



**Figure 14: Reference circuit of level shift**

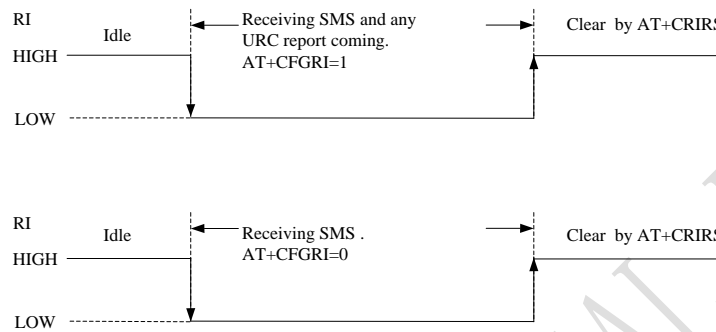
To comply with RS-232-C protocol, the RS-232-C level shifter chip should be used to connect SIM7500x to the RS-232-C interface, for example SP3238ECA, etc.

**Note:** SIM7500x supports the following baud rates: 300, 600, 1200, 2400, 4800, 9600, 19200, 38400, 57600, 115200, 230400, 460800, 921600, 3200000, 3686400, 4000000bps. The default band rate is 115200bps.

### 3.3.2 RI and DTR Behavior

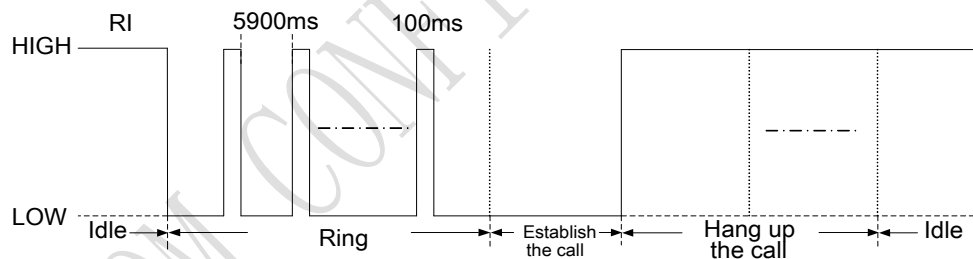
The RI pin can be used to interrupt output signal to inform the host controller such as application CPU.

Normally RI will stay at high level until certain conditions such as receiving SMS, or a URC report come in. It will then change to low level. It will stay low until the host controller clears the interrupted event with “AT+CRIRS” AT command.



**Figure 15: RI behaviour (SMS and URC report)**

Normally RI will be kept high until a voice call, then it will output periodic rectangular wave with 5900ms low level and 100ms high level. It will output this kind of periodic rectangular wave until the call is answered or hung up.



**Figure 16: RI behaviour (voice call)**

*Note: For more details of AT commands about UART, please refer to document [1] and [22].*

DTR pin can be used to wake SIM7500x from sleep. When SIM7500x enters sleep mode, pulling down DTR can wake SIM7500x.

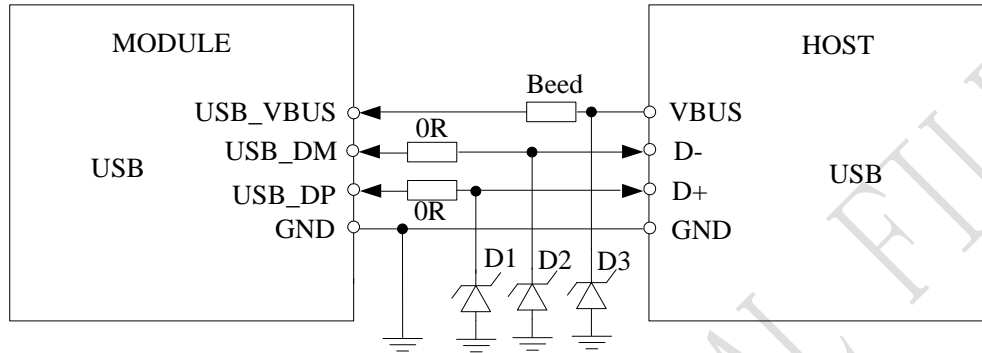
### 3.4 USB Interface

The SIM7500x contains a USB interface compliant with the USB2.0 specification as a peripheral, but the USB charging function is not supported.



### 3.4.1 USB Application Guide

SIM7500x can be used as a USB device. SIM7500x supports the USB suspend and resume mechanism which can reduce power consumption. If there is no data transmission on the USB bus, SIM7500x will enter suspend mode automatically and will be resumed by some events such as voice call, receiving SMS, etc.



**Figure 17: USB reference circuit**

Because of the high bit rate on USB bus, more attention should be paid to the influence of the junction capacitance of the ESD component on USB data lines. Typically, the capacitance should be less than 1pF. It is recommended to use an ESD protection component such as ESD9L5.0ST5G provided by On Semiconductor ([www.onsemi.com](http://www.onsemi.com)).

D3 is suggested to select the diode with anti-ESD and voltage surge function, or customer could add a ZENER diode for surge clamping. The recommend diodes list please refer to table 7.

**Note :** The USB\_DM and USB\_DP nets must be traced by 90Ohm+/-10% differential impedance.

### 3.5 USIM Interface

SIM7500x supports both 1.8V and 3.0V USIM Cards.

**Table 11: USIM Electronic characteristic in 1.8V mode (USIM\_VDD=1.8V)**

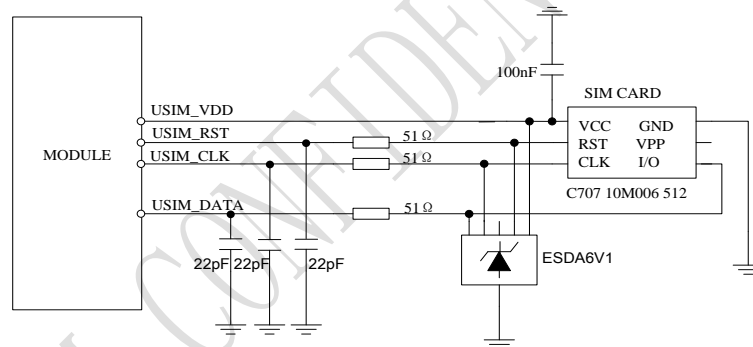
Symbol	Parameter	Min.	Typ.	Max.	Unit
USIM_VDD	LDO power output voltage	1.75	1.8	1.95	V
V <sub>IH</sub>	High-level input voltage	0.65*USIM_VDD	-	USIM_VDD +0.3	V
V <sub>IL</sub>	Low-level input voltage	-0.3	0	0.35*USIM_VDD	V
V <sub>OH</sub>	High-level output voltage	USIM_VDD -0.45	-	USIM_VDD	V
V <sub>OL</sub>	Low-level output voltage	0	0	0.45	V

**Table 12: USIM Electronic characteristic 3.0V mode (USIM\_VDD=2.95V)**

Symbol	Parameter	Min.	Typ.	Max.	Unit
USIM_VDD	LDO power output voltage	2.75	2.95	3.05	V
V <sub>IH</sub>	High-level input voltage	0.65*USIM_VDD	-	USIM_VDD +0.3	V
V <sub>IL</sub>	Low-level input voltage	-0.3	0	0.25*USIM_VDD	V
V <sub>OH</sub>	High-level output voltage	USIM_VDD -0.45	-	USIM_VDD	V
V <sub>OL</sub>	Low-level output voltage	0	0	0.45	V

### 3.5.1 USIM Application Guide

It is recommended to use an ESD protection component such as ESDA6V1W5 produced by ST ([www.st.com](http://www.st.com)) or SMF15C produced by ON SEMI ([www.onsemi.com](http://www.onsemi.com)). Note that the USIM peripheral circuit should be close to the USIM card socket. The following figure shows the 6-pin SIM card holder reference circuit.



**Figure 18: USIM interface reference circuit**

*Note: USIM\_DATA has been pulled up with a 100KΩ resistor to USIM\_VDD in module. A 100nF capacitor on USIM\_VDD is used to reduce interference. For more details of AT commands about USIM, please refer to document [1].*

### 3.5.2 SIM Card Design Guide

SIM card signal could be interfered by some high frequency signal, it is strongly recommended to follow these guidelines while designing:

- SIM card holder should be far away from antenna
- SIM traces should keep away from RF lines, VBAT and high-speed signal lines
- The traces should be as short as possible
- Keep SIM card holder's GND connect to main ground directly

- Shielding the SIM card signal by ground well
- Recommended to place a 100nF capacitor on SIM\_VDD line and keep close to the SIM card holder
- Add some TVS which parasitic capacitance should not exceed 50pF
- Add 51Ω resistor to (SIM\_RST/SIM\_CLK/SIM\_DATA) signal could enhance ESD protection
- Add 22pF capacitor to (SIM\_RST/SIM\_CLK/SIM\_DATA) signal to induce RF signal interference

### 3.5.3 Recommended USIM Card Holder

It is recommended to use the 6-pin USIM socket such as C707 10M006 512 produced by Amphenol. User can visit <http://www.amphenol.com> for more information about the holder.

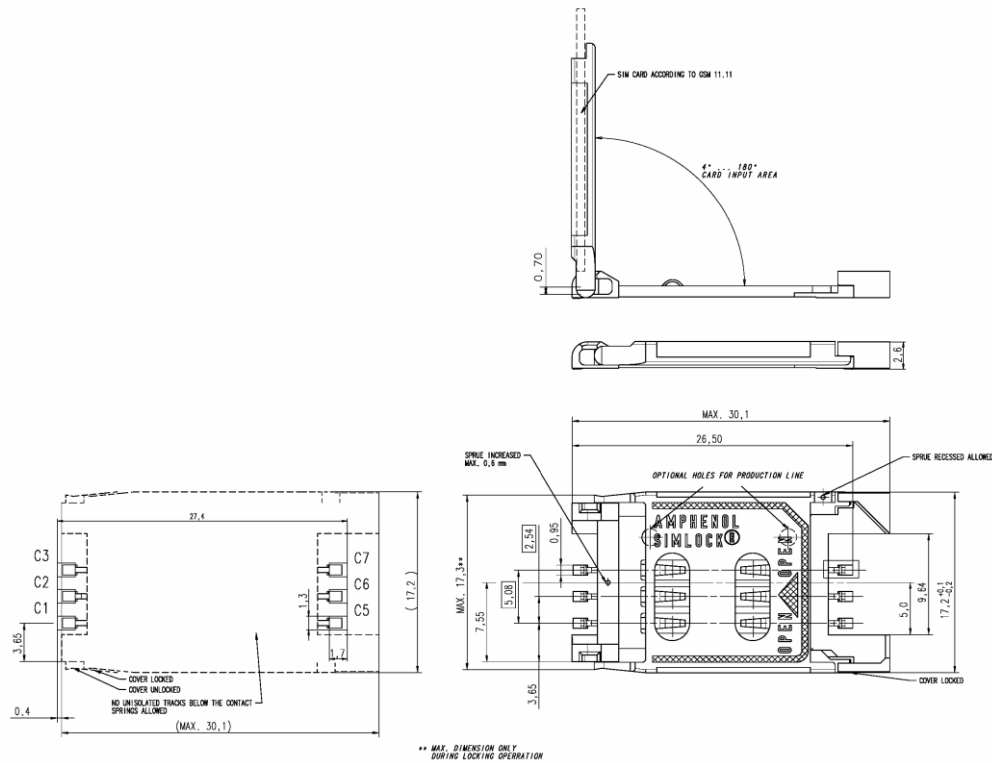


Figure 19: Amphenol SIM card socket

Table 13: Amphenol USIM Socket Pin Description

Pin	Signal	Description
C1	USIM_VDD	USIM Card Power supply.
C2	USIM_RST	USIM Card Reset.
C3	USIM_CLK	USIM Card Clock.
C5	GND	Connect to GND.
C6	VPP	
C7	USIM_DATA	USIM Card data I/O.

### 3.6 PCM Interface

SIM7500x provides a PCM interface for external codec, which can be used in master mode with short sync and 16 bits linear format.

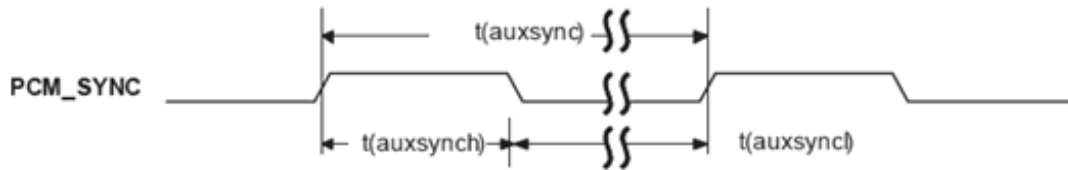
**Table 14: PCM Format**

Characteristics	Specification
Line Interface Format	Linear(Fixed)
Data length	16bits(Fixed)
PCM Clock/Sync Source	Master Mode(Fixed)
PCM Clock Rate	2048 KHz (Fixed)
PCM Sync Format	Short sync(Fixed)
Data Ordering	MSB

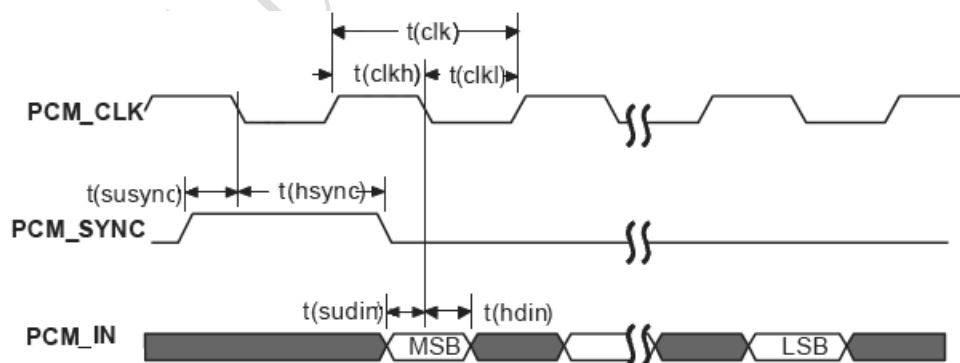
*Note: For more details about PCM AT commands, please refer to document [1].*

#### 3.6.1 PCM Timing

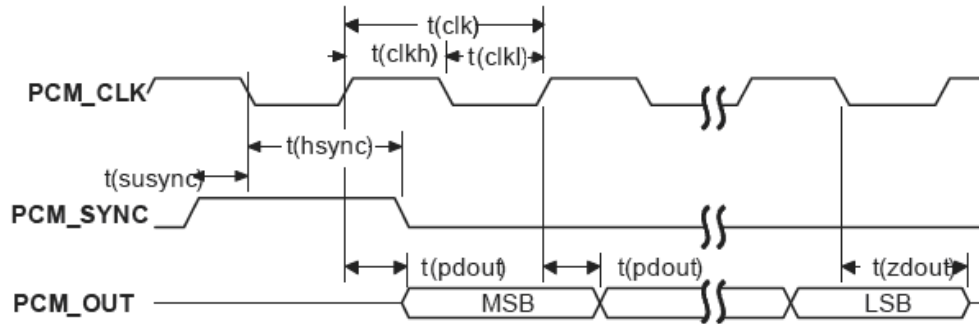
SIM7500x supports 2.048 MHz PCM data and sync timing for 16 bits linear format codec.



**Figure 20: PCM\_SYNC timing**



**Figure 21: EXT codec to module timing**



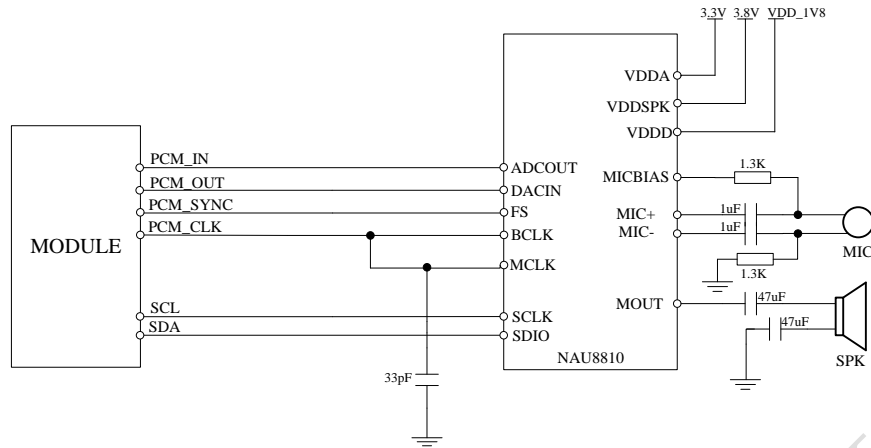
**Figure 22: Module to EXT codec timing**

**Table 15: PCM Timing Parameters**

Parameter	Description	Min.	Typ.	Max.	Unit
T(sync)	PCM_SYNC cycle time	–	125	–	μs
T(synch)	PCM_SYNC high level time	–	488	–	ns
T(sync <sub>l</sub> )	PCM_SYNC low level time	–	124.5	–	μs
T(clk)	PCM_CLK cycle time	–	488	–	ns
T(clkh)	PCM_CLK high level time	–	244	–	ns
T(clkl)	PCM_CLK low level time	–	244	–	ns
T(susync)	PCM_SYNC setup time high before falling edge of PCM_CLK	–	122	–	ns
T(hsync)	PCM_SYNC hold time after falling edge of PCM_CLK	–	366	–	ns
T(sudin)	PCM_IN setup time before falling edge of PCM_CLK	60	–	–	ns
T(hdin)	PCM_IN hold time after falling edge of PCM_CLK	60	–	–	ns
T(pdout)	Delay from PCM_CLK rising to PCM_OUT valid	–	–	60	ns
T(zdout)	Delay from PCM_CLK falling to PCM_OUT HIGH-Z	–	–	60	ns

### 3.6.2 PCM Application Guide

The following figure shows the external codec reference design.



**Figure 23: Audio codec reference circuit**

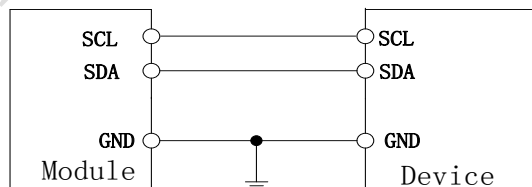
*Note: SIM7500x can transmit PCM data by the USB port besides the PCM interface. For more details please refer to documents [1] and [23].*

### 3.7 I2C Interface

SIM7500x provides a I2C interface compatible with I2C specification, version 2.1, with clock rate up to 400 kbps. Its operation voltage is 1.8V.

#### 3.7.1 I2C Design Guide

The following figure shows the I2C bus reference design.



**Figure 24: I2C reference circuit**

*Note :*

*SDA and SCL have pull-up resistors in module. So, 2 external pull up resistors are not needed in application circuit.*

*“AT+CRIIC and AT+CWIIC” AT commands could be used to read/write register values of the I2C peripheral devices. For more details about AT commands please refer to document [1].*

### 3.8 Network Status

The NETLIGHT pin is used to control Network Status LED, its reference circuit is shown in the following figure.

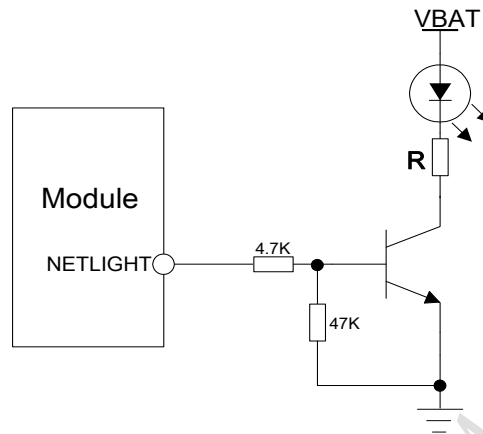


Figure 25: NETLIGHT reference circuit

*Note: The value of the resistor named “R” depends on the LED characteristic.*

Table 16: NETLIGHT pin status

NETLIGHT pin status	Module status
Always On	Searching Network/Call Connect
200ms ON, 200ms OFF	Data Transmit
800ms ON, 800ms OFF	Registered network
OFF	Power off / Sleep

*Note: NETLIGHT output low level as “OFF”, and high level as “ON”.*

### 3.9 Operating Status Indication

The pin50 is for operating status indication of the module. The pin output is high when module is powered on, and output is low when module is powered off.

Table 17: Pin definition of the STATUS

Pin name	Pin number	Description
STATUS	50	Operating status indication

*Note: For timing about STATUS, please reference to the chapter “3.2 power on/down scenarios”*

### 3.10 Pin Multiplex Function

Some pins of SIM7500x could be used for alternate function besides default function.

**Table 18: Pin multiplex function list**

Pin Number	Pin Name	Default Function	Alternate Function
4	SCL	SCL	GPIO11
5	SDA	SDA	GPIO10
12	USIM_DET	GPIO34	USIM_DET
18	PCM_CLK	PCM_CLK	GPIO23,SPI_CLK I2C_SCL
19	PCM_SYNC	PCM_SYNC	GPIO20,SPI_MOSI
20	PCM_IN	PCM_IN,	GPIO21,SPI_MISO
21	PCM_OUT	PCM_OUT	GPIO22,SPI_CS_N I2C_SDA

*Note: For more details of AT commands about GPIO multiplex function, please refer to document [1].*

### 3.11 Other interface

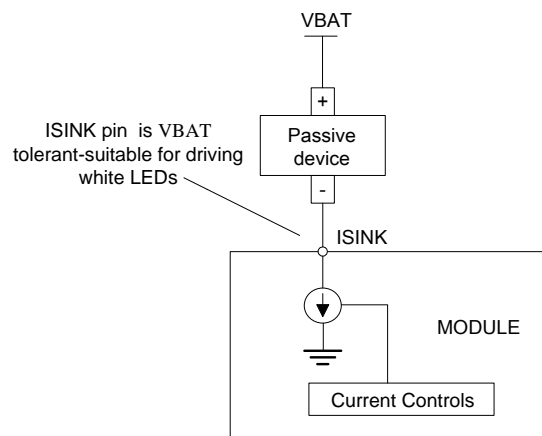
#### 3.11.1 Sink Current Source

The ISINK pin is VBAT tolerant and intended to drive some passive devices such as LCD backlight, white LED, etc. Its output current can be up to 40 mA and be set by the AT command “AT+ CLEDITST”.

**Table 19: Sink current electronic characteristic**

Symbol	Description	Min.	Typ.	Max.	Unit
$V_{ISINK}$	Voltage tolerant	0.5	-	VBAT	V
$I_{ISINK}$	Current tolerant	0	-	40	mA

ISINK is a ground-referenced current sink. The following figure shows its reference circuit.



**Figure 26: ISINK reference circuit**



*Note: The sinking current can be adjusted to meet the design requirement through the AT command “AT+ CLEDITST =<0>, <value>”. The “value” ranges from 0 to 8, on behalf of the current from 0mA to 40mA by 5mA step.*

### 3.11.2 ADC

SIM7500x has 1 dedicated ADC pins named ADC. They are available for digitizing analog signals such as battery voltage and so on. These electronic specifications are shown in the following table.

**Table 20: ADC Electronic Characteristics**

Characteristics	Min.	Typ.	Max.	Unit
Resolution	–	15	–	Bits
Input Range	0.1		1.7	V
Input serial resistance	1	–	–	MΩ

*Note: “AT+CADC” can be used to read the voltage of the ADC pins, for more details, please refer to document [1].*

## 4 RF Specifications

### 4.1 WCDMA/LTE RF Specifications

**Table 21: Conducted transmission power**

Frequency	Power	Min.
WCDMA B2	24dBm +1/-3dB	<-50dBm
WCDMA B5	24dBm +1/-3dB	<-50dBm
LTE-FDD B1	23dBm +/-2.7dB	<-40dBm
LTE-FDD B2	23dBm +/-2.7dB	<-40dBm
LTE-FDD B3	23dBm +/-2.7dB	<-40dBm
LTE-FDD B4	23dBm +/-2.7dB	<-40dBm
LTE-FDD B8	23dBm +/-2.7dB	<-40dBm
LTE-FDD B17	23dBm +/-2.7dB	<-40dBm

**Table 22: Operating frequencies**

Frequency	Receiving	Transmission
WCDMA B2	1930~1990 MHz	1850~1910 MHz
WCDMA B5	869~894 MHz	824~849 MHz
LTE-FDD B1	1920 ~1980 MHz	2110 ~2170 MHz
LTE-FDD B2	1930 ~1990 MHz	1850 ~1910 MHz
LTE-FDD B3	1710 ~1785 MHz	1805 ~1880 MHz
LTE-FDD B4	2110 ~2155 MHz	1710 ~1755 MHz
LTE-FDD B8	880 ~915 MHz	925~960 MHz
LTE-FDD B17	734 ~746 MHz	704 ~716 MHz

**Table 23: Conducted receive sensitivity**

Frequency	Receive sensitivity(Typical)	Receive sensitivity(MAX)
WCDMA 1900	< -110dBm	3GPP
WCDMA 850	< -110dBm	3GPP
LTE	See table 24	3GPP

**Table 24: Reference sensitivity (QPSK)**

E-UTRA band	3GPP standard				Test value	3GPP standard		Duplex
	1.4 MHz	3MHz	5MHz	10MHz	10 MHz	15 MHz	20 MHz	
1	-	-	-100	-97	-101.3	-95.2	-94	FDD
2	-102.7	-99.7	-98	-95	-101	-93.2	-92	FDD
3	-101.7	-98.7	-97	-94	-100	-92.2	-91	FDD
4	-104.7	-101.7	-100	-97	-102	-95.2	-94	FDD
8	-102.2	-99.2	-97	-94	-99.8			FDD
17	-	-	-97	-94	-102.4			FDD

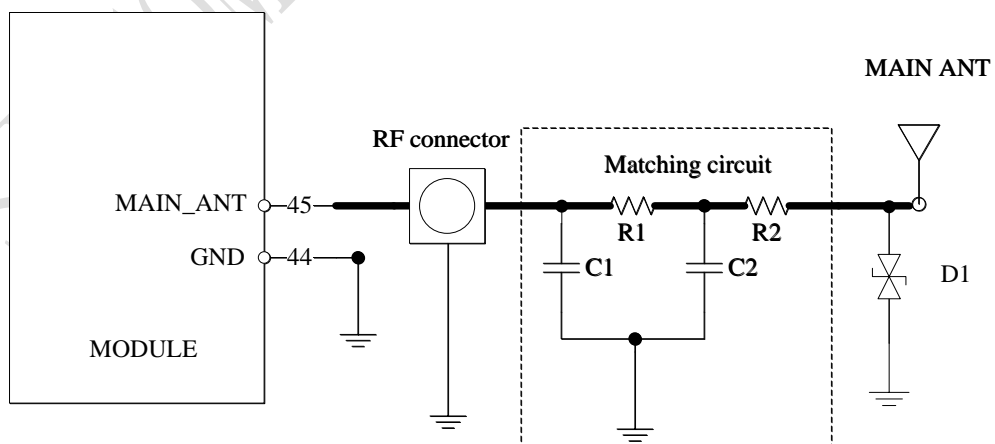
## 4.2 WCDMA/LTE Antenna Design Guide

Users should connect antennas to SIM7500x's antenna pads through the micro-strip line or other types of RF trace. The trace impedance must be controlled in 50Ω. SIMCom recommends that the total insertion loss between SIM7500x and antenna should meet the following requirements:

**Table 25: Trace Loss**

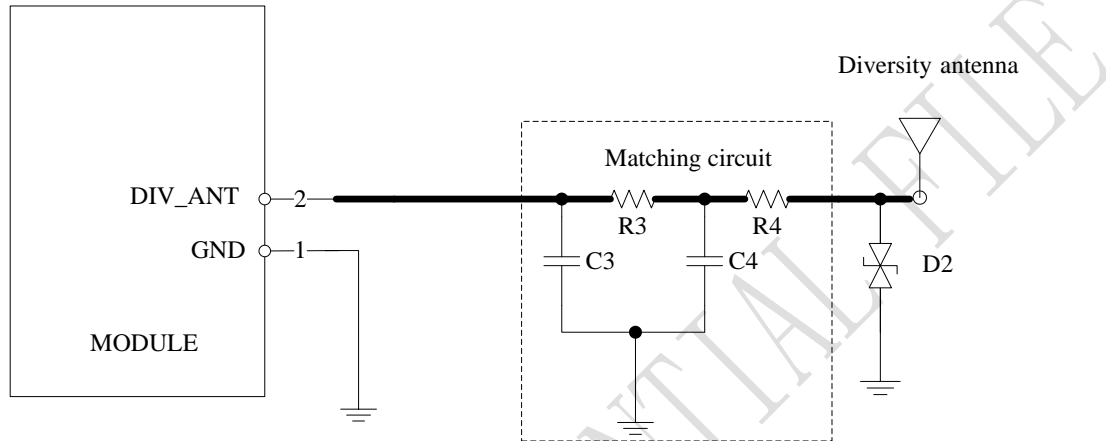
Frequency	Loss
700MHz-960MHz	<0.5dB
1710MHz-2170MHz	<0.9dB

To facilitate the antenna tuning and certification test, a RF connector and an antenna matching circuit should be added. The following figure is the recommended circuit.



**Figure 27: Antenna matching circuit (MAIN\_ANT)**

In above figure, the components R1,C1,C2 and R2 are used for antenna matching, the value of components can only be achieved after the antenna tuning and usually provided by antenna vendor. By default, the R1, R2 are  $0\Omega$  resistors, and the C1, C2 are reserved for tuning. The component D1 is a TVS for ESD protection, and it is optional for users according to application environment. The RF test connector is used for the conducted RF performance test, and should be placed as close as to the module's MAIN\_ANT pin. The traces impedance between SIM7500x and antenna must be controlled in  $50\Omega$ .



**Figure 28: Antenna matching circuit (DIV\_ANT)**

In above figure, R3, C3, C4 and R4 are used for auxiliary antenna matching. By default, the R3, R4 are  $0\Omega$  resistors, and the C3, C4 are reserved for tuning. D2 is a TVS for ESD protection, and it is optional for users according to application environment.

Two TVS are recommended in the table below.

**Table 26: Recommended TVS**

Package	Part Number	Vender
0201	LXES03AAA1-154	Murata
0402	LXES15AAA1-153	Murata

**Note:** SIMCom suggests the LTE auxiliary antenna to be kept on, since there are many high bands in the designing of FDD-LTE. Because of the high insert loss of the RF cable and layout lines, the receiver sensitivity of these bands above will have risk to meet the authentication without the diversity antenna. For more details about auxiliary antenna design notice, please refer to document [25]

## 5 Electrical Specifications

### 5.1 Absolute Maximum Ratings

Absolute maximum rating for digital and analog pins of SIM7500x are listed in the following table:

**Table 27: Absolute maximum ratings**

Parameter	Min.	Max.	Unit
Voltage at VBAT	-0.5	6.0	V
Voltage at VBUS	-0.5	6.3	V
Voltage at digital pins (RESET,SPI,GPIO,I2C,UART,PCM)	-0.3	2.1	V
Voltage at digital pins :USIM	-0.3	3.05	V
Voltage at PWRKEY	-0.3	1.8	

### 5.2 Operating Conditions

**Table 28: Recommended operating ratings**

Parameter	Min.	Typ.	Max.	Unit
Voltage at VBAT	3.4	3.8	4.2	V
Voltage at VBUS	3.6	5	5.25	V

**Table 29: 1.8V Digital I/O characteristics\***

Parameter	Description	Min.	Typ.	Max.	Unit
V <sub>IH</sub>	High-level input voltage	1.17	1.8	2.1	V
V <sub>IL</sub>	Low-level input voltage	-0.3	0	0.63	V
V <sub>OH</sub>	High-level output voltage	1.35	-	1.8	V
V <sub>OL</sub>	Low-level output voltage	0	-	0.45	V
I <sub>OH</sub>	High-level output current(no pull down resistor)	-	2		mA
I <sub>OL</sub>	Low-level output current(no pull up resistor)	-	-2	-	mA
I <sub>IH</sub>	Input high leakage current (no pull down resistor)	-	-	1	uA
I <sub>IL</sub>	Input low leakage current(no pull up resistor)	-1	-	-	uA

**\*Note:** These parameters are for digital interface pins, such as SPI, GPIOs (NETLIGHT), I2C, UART, PCM.

The operating temperature of SIM7500x is listed in the following table.

**Table 30: Operating temperature**

Parameter	Min.	Typ.	Max.	Unit
Normal operation temperature	-30	25	80	°C
Extended operation temperature*	-40	25	85	°C
Storage temperature	-45	25	+90	°C

*\*Note: Module is able to make and receive voice calls, data calls, SMS and make WCDMA/HSPA+/LTE traffic in -40°C ~ +85°C. The performance will be reduced slightly from the 3GPP specifications if the temperature is outside the normal operating temperature range and still within the extreme operating temperature range.*

## 5.3 Operating Mode

### 5.3.1 Operating Mode Definition

The table below summarizes the various operating modes of SIM7500x series products.

**Table 31: Operating mode Definitions**

Mode	Function
Normal operation	WCDMA / LTE Sleep In this case, the current consumption of module will be reduced to the minimal level and the module can still receive paging message and SMS.
	WCDMA / LTE Idle Software is active. Module is registered to the network, and the module is ready to communicate.
	WCDMA / LTE Talk Connection between two subscribers is in progress. In this case, the power consumption depends on network settings such as DTX off/on, FR/EFR/HR, hopping sequences, antenna.
	WCDMA/LTE Standby Module is ready for data transmission, but no data is currently sent or received. In this case, power consumption depends on network settings.
	WCDMA / LTE transmission There is data transmission in progress. In this case, power consumption is related to network settings (e.g. power control level); uplink/downlink data rates, etc.
Minimum functionality mode	AT command “AT+CFUN=0” can be used to set the module to a minimum functionality mode without removing the power supply. In this mode, the RF part of the module will not work and the USIM card will not be accessible, but the serial port and USB port are still accessible. The power consumption in this mode is lower than normal mode.
Flight mode	AT command “AT+CFUN=4” or pulling down the FLIGHTMODE pin can be used to set the module to flight mode without removing the

	power supply. In this mode, the RF part of the module will not work but the serial port and USB port are still accessible. The power consumption in this mode is lower than normal mode.
Power off	Module will go into power off mode by sending the AT command “AT+CPOF” or by pulling down the PWRKEY pin normally. In this mode the power management unit shuts down the power supply and software is not active. The serial port and USB are is not accessible.

### 5.3.2 Sleep Mode

In sleep mode, the current consumption of module will be reduced to the minimal level, and module can still receive paging message and SMS.

Several hardware and software conditions must be satisfied together in order to let SIM7500x enter into sleep mode:

1. UART condition
2. USB condition
3. Software condition

**Note:** Before designing, pay attention to how to realize sleeping/waking function and refer to Document [26] for more details.

### 5.3.3 Minimum Functionality Mode and Flight Mode

Minimum functionality mode ceases a majority function of module, thus minimizing the power consumption. This mode is set by the AT command which provides a choice of the functionality levels.

- AT+CFUN=0: Minimum functionality
- AT+CFUN=1: Full functionality (Default)
- AT+CFUN=4: Flight mode

If SIM7500x has been set to minimum functionality mode, the RF function and USIM card function will be closed. In this case, the serial port and USB are still accessible, but RF function and USIM card will be unavailable.

If SIM7500x has been set to flight mode, the RF function will be closed. In this case, the serial port and USB are still accessible, but RF function will be unavailable.

When SIM7500x is in minimum functionality or flight mode, it can return to full functionality by the AT command “AT+CFUN=1”.

## 5.4 Current Consumption

The current consumption is listed in the table below.

**Table 32: Current consumption on VBAT Pins (VBAT=3.8V)**

UMTS Sleep/Idle Mode			
WCDMA supply current (without USB connection)	Sleep mode @DRX=9    Typical: 1.11		
	Idle mode @DRX=9    Typical: 17.5		
LTE Sleep/Idle mode			
LTE supply current (without USB connection)	Sleep mode Typical: 1.56		
	Idle mode Typical: 22		
UMTS Talk			
WCDMA B2	@Power 22dBm	Typical: 524mA	
WCDMA B5	@Power 23.48dBm	Typical: 480mA	
HSDPA Data			
WCDMA B2	@Power 24dBm Typical: TBD		
WCDMA B5	@Power 24dBm Typical: TBD		
LTE Data			
LTE-FDD B1	@5 MHz	22.2dBm	Typical: 482mA
	@10 MHz	22.7dBm	Typical: 489mA
	@20 MHz	22.38dBm	Typical: 534mA
LTE-FDD B2	@5 MHz	22.2dBm	Typical: 589mA
	@10 MHz	22.7dBm	Typical: 577mA
	@20 MHz	22.38dBm	Typical: 626mA
LTE-FDD B3	@5 MHz	22.2dBm	Typical: 479mA
	@10 MHz	22.7dBm	Typical: 491mA
	@20 MHz	22.38dBm	Typical: 538mA
LTE-FDD B4	@5 MHz	23.05dBm	Typical: 519mA
	@10 MHz	23.04dBm	Typical: 556mA
	@20 MHz	22.83dBm	Typical: 600mA
LTE-FDD B8	@5 MHz	22.2dBm	Typical: 476mA
	@10 MHz	22.7dBm	Typical: 481mA
LTE-FDD B17	@5 MHz	22.69dBm	Typical: 516mA
	@10 MHz	22.9dBm	Typical: 512mA

## 5.5 ESD Notes

SIM7500x is sensitive to ESD in the process of storage, transporting and assembling. Especially, SIM7500x is mounted on the users' mother board, The ESD components should be placed beside the connectors which human body might touch, such as USIM card holder, audio jacks, switches and keys, etc. The following table shows the SIM7500x ESD measurement performance without any external ESD component.

**Table 33: The ESD performance measurement table (Temperature: 25°C, Humidity: 45%)**

Part	Contact discharge	Air discharge
GND	+/-6K	+/-12K
VBAT	+/-5K	+/-10K
Antenna port	+/-5K	+/-10K



USB	+/-4K	+/-8K
UART	+/-4K	+/-8K
PCM	+/-4K	+/-8K
Other PADs	+/-3K	+/-6K

SIMCOM CONFIDENTIAL FILE

## 6 SMT Production Guide

### 6.1 Top and Bottom View of SIM7500x



Figure 29: Top and bottom view of SIM7500x

## 6.2 Label Information



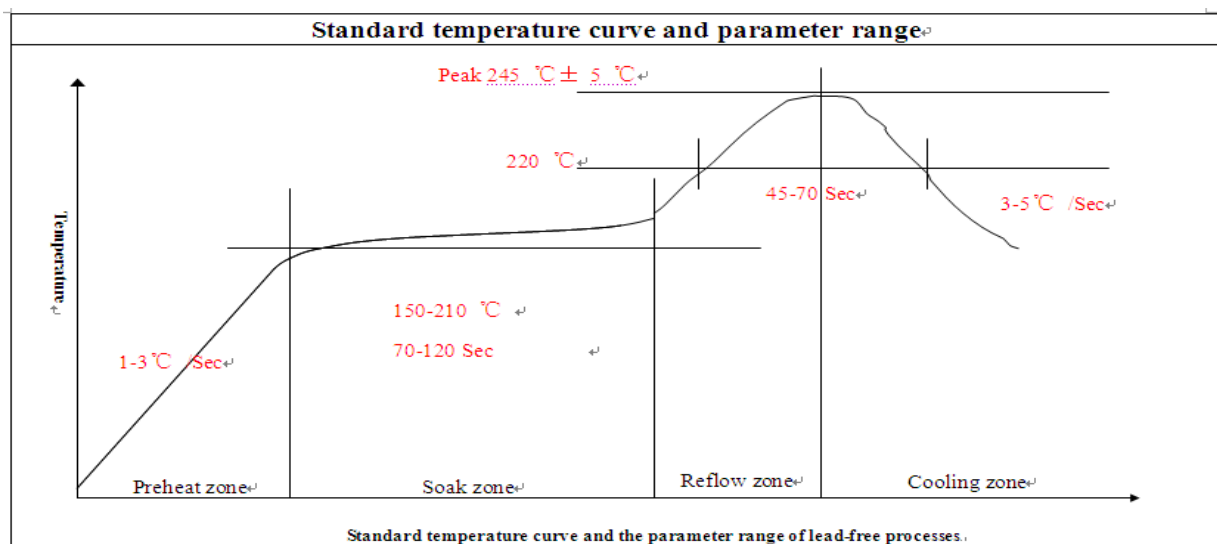
Figure 30: Label Information

Table 34: The Description of Label Information

No.	Description
A	LOGO
B	No.1 Pin
C	Project Name
D	Product Code
E	Serial Number
F	International Mobile Equipment Identity
G	QR code

## 6.3 Typical SMT Reflow Profile

SIMCom provides a typical soldering profile. Therefore the soldering profile shown below is only a generic recommendation and should be adjusted to the specific application and manufacturing constraints.



**Figure 31: The ramp-soak-spike Reflow Profile of SIM7500x**

*Note: For more details about secondary SMT, please refer to the document [21].*

## 6.4 Moisture Sensitivity Level (MSL)

SIM7500x is qualified to Moisture Sensitivity Level (MSL) 3 in accordance with JEDEC J-STD-033. If the prescribed time limit is exceeded, users should bake modules for 192 hours in drying equipment (<5% RH) at 40+5/-0 °C, or 72 hours at 85+5/-5 °C. Note that plastic tray is not heat-resistant, and only can be baked at 45 °C.

**Table 35: Moisture Sensitivity Level and Floor Life**

Moisture Sensitivity Level (MSL)	Floor Life (out of bag) at factory ambient ≤30°C/60% RH or as stated
1	Unlimited at ≤30°C/85% RH
2	1 year
2a	4 weeks
3	168 hours
4	72 hours
5	48 hours
5a	24 hours
6	Mandatory bake before use. After bake, it must be reflowed within the time limit specified on the label.

**NOTE:** IPC / JEDEC J-STD-033 standard must be followed for production and storage.

## 6.5 Stencil Foil Design Recommendation

The recommended thickness of stencil foil is more than 0.1mm.

SIMCOM CONFIDENTIAL FILE

## 7 Packaging

SIM7500x module support tray packaging.

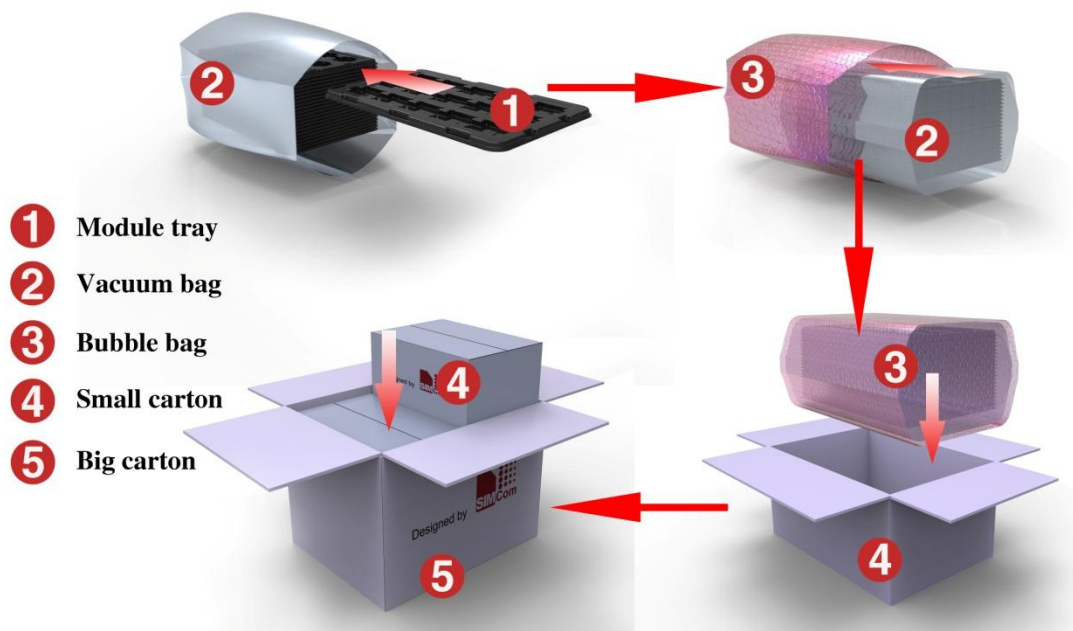


Figure 32: Packaging introduce

Module tray drawing:

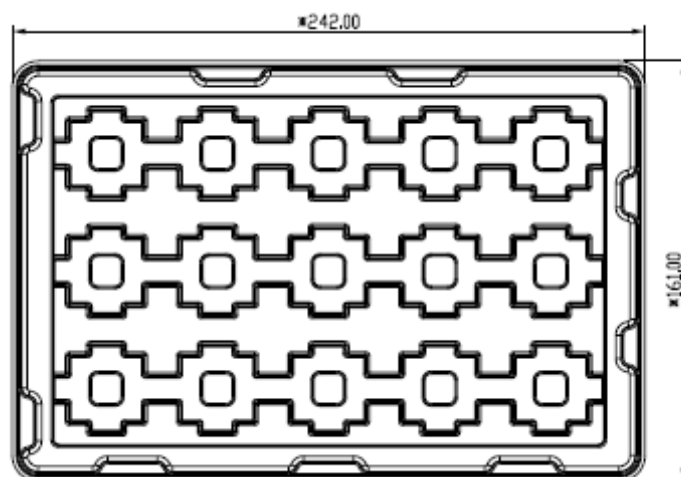


Figure 33: Module tray drawing introduce

Table 36: Tray size

Length ( $\pm 3\text{mm}$ )	Width ( $\pm 3\text{mm}$ )	Module number
242.0	161.0	15

Small carton drawing:

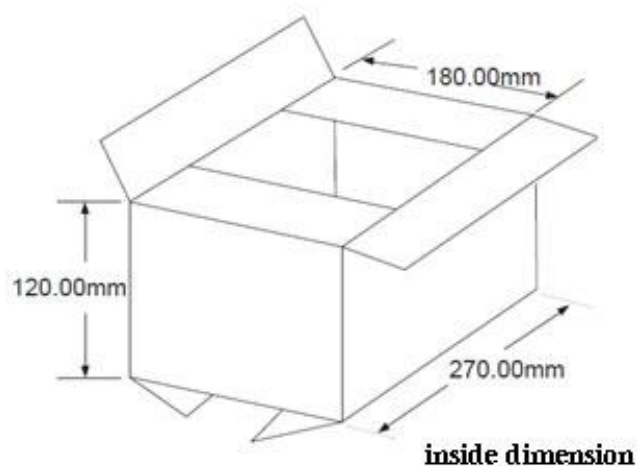


Figure 34: Small carton drawing introduce

Table 37: Small Carton size

Length (±10mm)	Width (±10mm)	Height (±10mm)	Module number
270	180	120	15*20=300

Big carton drawing:

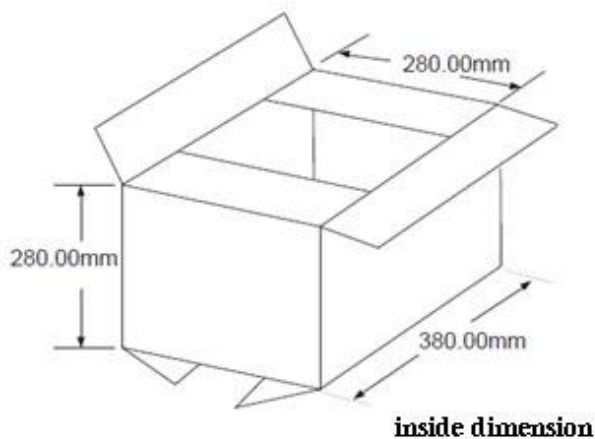


Figure 35: Big carton drawing introduce

Table 38: Big carton size

Length (±10mm)	Width (±10mm)	Height (±10mm)	Module number
380	280	280	300*4=1200

## Appendix

### A. Reference Design

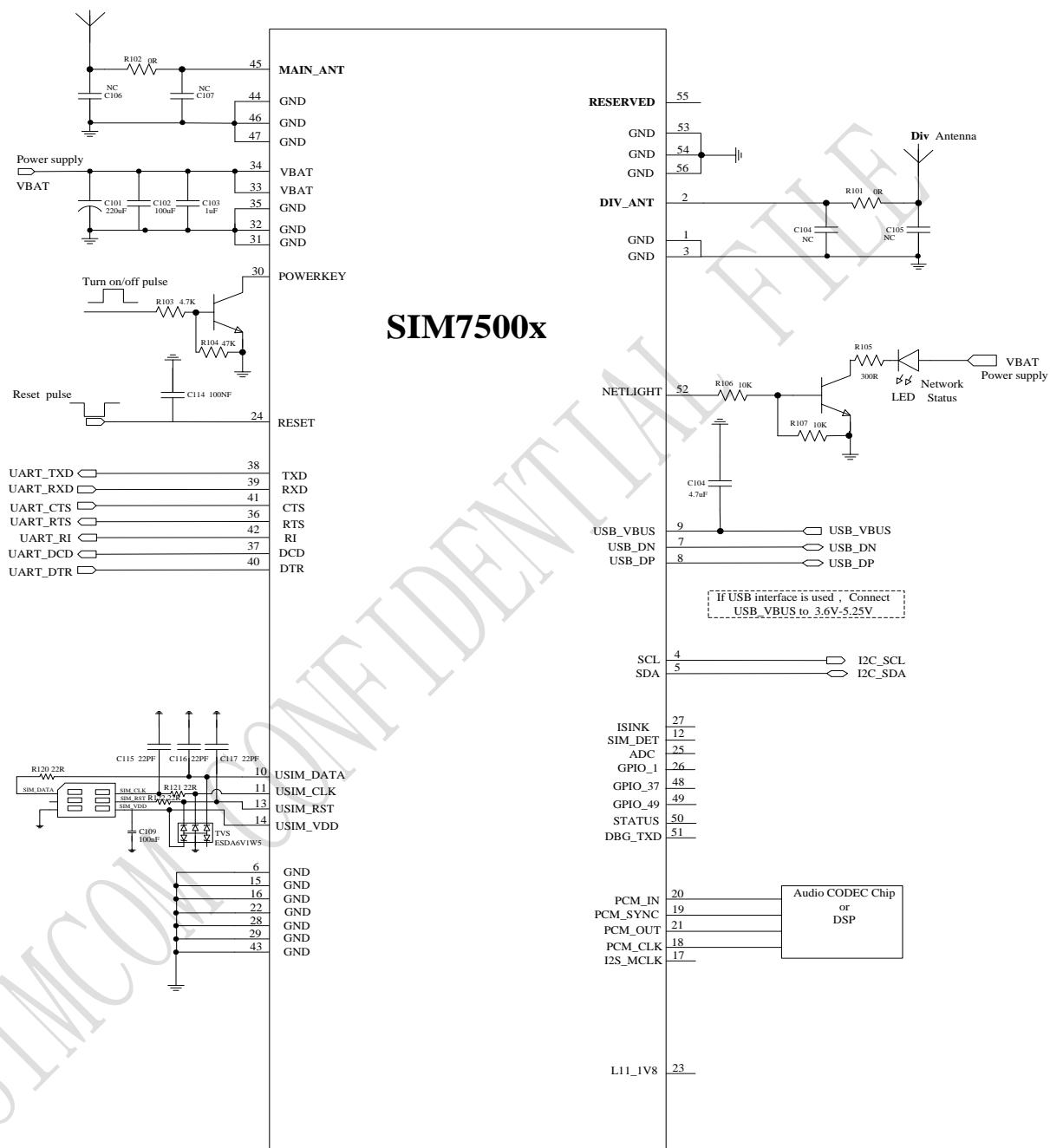


Figure 36: Reference design

*Note: The UART port suggest to be used by isolated circuit .*



## B. Coding Schemes and Maximum Net Data Rates over Air Interface

Table 39: Coding schemes and maximum net data rates over air interface

Multislot definition(GPRS/EDGE)			
Slot class	DL slot number	UL slot number	Active slot number
1	1	1	2
2	2	1	3
3	2	2	3
4	3	1	4
5	2	2	4
6	3	2	4
7	3	3	4
8	4	1	5
9	3	2	5
10	4	2	5
11	4	3	5
12	4	4	5
GPRS coding scheme	Max data rate (4 slots)		Modulation type
CS 1 = 9.05 kb/s / time slot	36.2 kb/s		GMSK
CS 2 = 13.4 kb/s / time slot	53.6 kb/s		GMSK
CS 3 = 15.6 kb/s / time slot	62.4 kb/s		GMSK
CS 4 = 21.4 kb/s / time slot	85.6 kb/s		GMSK
EDGE coding scheme	Max data rate (4 slots)		Modulation type
MCS 1 = 8.8 kb/s/ time slot	35.2 kb/s		GMSK
MCS 2 = 11.2 kb/s/ time slot	44.8 kb/s		GMSK
MCS 3 = 14.8 kb/s/ time slot	59.2 kb/s		GMSK
MCS 4 = 17.6 kb/s/ time slot	70.4 kb/s		GMSK
MCS 5 = 22.4 kb/s/ time slot	89.6 kb/s		8PSK
MCS 6 = 29.6 kb/s/ time slot	118.4 kb/s		8PSK
MCS 7 = 44.8 kb/s/ time slot	179.2 kb/s		8PSK
MCS 8 = 54.4 kb/s/ time slot	217.6 kb/s		8PSK
MCS 9 = 59.2 kb/s/ time slot	236.8 kb/s		8PSK
HSDPA device category	Max data rate (peak)		Modulation type
Category 1	1.2Mbps		16QAM,QPSK
Category 2	1.2Mbps		16QAM,QPSK
Category 3	1.8Mbps		16QAM,QPSK
Category 4	1.8Mbps		16QAM,QPSK
Category 5	3.6Mbps		16QAM,QPSK
Category 6	3.6Mbps		16QAM,QPSK
Category 7	7.2Mbps		16QAM,QPSK
Category 8	7.2Mbps		16QAM,QPSK

Category 9	10.2Mbps	16QAM,QPSK
Category 10	14.4Mbps	16QAM,QPSK
Category 11	0.9Mbps	QPSK
Category 12	1.8Mbps	QPSK
Category 13	17.6Mbps	64QAM
Category 14	21.1Mbps	64QAM
Category 15	23.4Mbps	16QAM
Category 16	28Mbps	16QAM
Category 17	23.4Mbps	64QAM
Category 18	28Mbps	64QAM
Category 19	35.5Mbps	64QAM
Category 20	42Mbps	64QAM
Category 21	23.4Mbps	16QAM
Category 22	28Mbps	16QAM
Category 23	35.5Mbps	64QAM
Category 24	42.2Mbps	64QAM
<b>HSUPA device category</b>	<b>Max data rate (peak)</b>	<b>Modulation type</b>
Category 1	0.96Mbps	QPSK
Category 2	1.92Mbps	QPSK
Category 3	1.92Mbps	QPSK
Category 4	3.84Mbps	QPSK
Category 5	3.84Mbps	QPSK
Category 6	5.76Mbps	QPSK
<b>LTE-FDD device category (Downlink)</b>	<b>Max data rate (peak)</b>	<b>Modulation type</b>
Category 1	10Mbps	QPSK/16QAM/64QAM
Category 2	50Mbps	QPSK/16QAM/64QAM
Category 3	100Mbps	QPSK/16QAM/64QAM
Category 4	150Mbps	QPSK/16QAM/64QAM
<b>LTE-FDD device category (Uplink)</b>	<b>Max data rate (peak)</b>	<b>Modulation type</b>
Category 1	5Mbps	QPSK/16QAM
Category 2	25Mbps	QPSK/16QAM
Category 3	50Mbps	QPSK/16QAM
Category 4	50Mbps	QPSK/16QAM

## C. Related Documents

**Table 40: Related documents**

SN	Title	Description
[1]	SIM7X00 Series_AT Command Manual_V1.xx	SIM7X00 Series_AT Command Manual
[2]	ITU-T Draft new recommendation V.25ter	Serial asynchronous automatic dialing and control
[3]	GSM 07.07	Digital cellular telecommunications (Phase 2+); AT command set for GSM Mobile Equipment (ME)
[4]	GSM 07.10	Support GSM 07.10 multiplexing protocol
[5]	GSM 07.05	Digital cellular telecommunications (Phase 2+); Use of Data Terminal Equipment – Data Circuit terminating Equipment (DTE – DCE) interface for Short Message Service (SMS) and Cell Broadcast Service (CBS)
[6]	GSM 11.14	Digital cellular telecommunications system (Phase 2+); Specification of the SIM Application Toolkit for the Subscriber Identity Module – Mobile Equipment (SIM – ME) interface
[7]	GSM 11.11	Digital cellular telecommunications system (Phase 2+); Specification of the Subscriber Identity Module – Mobile Equipment (SIM – ME) interface
[8]	GSM 03.38	Digital cellular telecommunications system (Phase 2+); Alphabets and language-specific information
[9]	GSM 11.10	Digital cellular telecommunications system (Phase 2) ; Mobile Station (MS) conformance specification; Part 1: Conformance specification
[10]	3GPP TS 51.010-1	Digital cellular telecommunications system (Release 5); Mobile Station (MS) conformance specification
[11]	3GPP TS 34.124	Electromagnetic Compatibility (EMC) for mobile terminals and ancillary equipment.
[12]	3GPP TS 34.121	Electromagnetic Compatibility (EMC) for mobile terminals and ancillary equipment.
[13]	3GPP TS 34.123-1	Technical Specification Group Radio Access Network; Terminal conformance specification; Radio transmission and reception (FDD)
[14]	3GPP TS 34.123-3	User Equipment (UE) conformance specification; Part 3: Abstract Test Suites.
[15]	EN 301 908-02 V2.2.1	Electromagnetic compatibility and Radio spectrum Matters (ERM); Base Stations (BS) and User Equipment (UE) for IMT-2000. Third Generation cellular networks; Part 2: Harmonized EN for IMT-2000, CDMA Direct Spread (UTRA FDD) (UE) covering essential requirements of article 3.2 of the R&TTE Directive
[16]	EN 301 489-24 V1.2.1	Electromagnetic compatibility and Radio Spectrum Matters (ERM); Electromagnetic Compatibility (EMC) standard for radio equipment and services; Part 24: Specific conditions for IMT-2000 CDMA Direct Spread (UTRA) for Mobile and portable (UE) radio and ancillary equipment
[17]	IEC/EN60950-1(2001)	Safety of information technology equipment (2000)
[18]	3GPP TS 51.010-1	Digital cellular telecommunications system (Release 5); Mobile Station (MS) conformance specification

[19]	GCF-CC V3.23.1	Global Certification Forum - Certification Criteria
[20]	2002/95/EC	Directive of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS)
[21]	Module secondary-SMT-UGD-V1.xx	Module secondary SMT Guidelines
[22]	SIM7X00 Series_UART_Application Note_V1.xx	SIM7X00 Series_UART_Application Note
[23]	SIM7X00 Series_USB AUDIO_Application Note_V1.xx	SIM7X00 Series_USB AUDIO_Application Note
[24]	Antenna design guidelines for diversity receiver system	Antenna design guidelines for diversity receiver system
[25]	SIM7X00 Series_Sleep Mode_Application Note_V1.xx	SIM7X00 Series_Sleep Mode_Application Note

SIMCOM CONFIDENTIAL

## D. Terms and Abbreviations







**Table 41: Terms and Abbreviations**

Abbreviation	Description
ADC	Analog-to-Digital Converter
ARP	Antenna Reference Point
BER	Bit Error Rate
BTS	Base Transceiver Station
CS	Coding Scheme
CSD	Circuit Switched Data
CTS	Clear to Send
DAC	Digital-to-Analog Converter
DRX	Discontinuous Reception
DSP	Digital Signal Processor
DTE	Data Terminal Equipment (typically computer, terminal, printer)
DTR	Data Terminal Ready
DTX	Discontinuous Transmission
EFR	Enhanced Full Rate
EGSM	Enhanced GSM
EMC	Electromagnetic Compatibility
ESD	Electrostatic Discharge
ETS	European Telecommunication Standard
EVDO	Evolution Data Only
FCC	Federal Communications Commission (U.S.)
FD	SIM fix dialing phonebook
FDMA	Frequency Division Multiple Access
FR	Full Rate
GMSK	Gaussian Minimum Shift Keying
GPRS	General Packet Radio Service
GSM	Global Standard for Mobile Communications
HR	Half Rate
HSPA	High Speed Packet Access
I2C	Inter-Integrated Circuit
IMEI	International Mobile Equipment Identity
LTE	Long Term Evolution
MO	Mobile Originated
MS	Mobile Station (GSM engine), also referred to as TE
MT	Mobile Terminated
PAP	Password Authentication Protocol
PBCCH	Packet Switched Broadcast Control Channel
PCB	Printed Circuit Board
PCS	Personal Communication System, also referred to as GSM 1900
RF	Radio Frequency
RMS	Root Mean Square (value)
RTC	Real Time Clock
SIM	Subscriber Identification Module

SMS	Short Message Service
SPI	serial peripheral interface
SMPS	Switched-mode power supply
TDMA	Time Division Multiple Access
TE	Terminal Equipment, also referred to as DTE
TX	Transmit Direction
UART	Universal Asynchronous Receiver & Transmitter
VSWR	Voltage Standing Wave Ratio
SM	SIM phonebook
NC	Not connect
EDGE	Enhanced data rates for GSM evolution
HSDPA	High Speed Downlink Packet Access
HSUPA	High Speed Uplink Packet Access
ZIF	Zero intermediate frequency
WCDMA	Wideband Code Division Multiple Access
VCTCXO	Voltage control temperature-compensated crystal oscillator
USIM	Universal subscriber identity module
UMTS	Universal mobile telecommunications system
UART	Universal asynchronous receiver transmitter

## E. Safety Caution

**Table 42: Safety caution**

Marks	Requirements
	When in a hospital or other health care facility, observe the restrictions about the use of mobiles. Switch the cellular terminal or mobile off, medical equipment may be sensitive and not operate normally due to RF energy interference.
	Switch off the cellular terminal or mobile before boarding an aircraft. Make sure it is switched off. The operation of wireless appliances in an aircraft is forbidden to prevent interference with communication systems. Forgetting to think much of these instructions may impact the flight safety or offend local legal action, or both.
	Do not operate the cellular terminal or mobile in the presence of flammable gases or fumes. Switch off the cellular terminal when you are near petrol stations, fuel depots, chemical plants or where blasting operations are in progress. Operation of any electrical equipment in potentially explosive atmospheres can constitute a safety hazard.
	Your cellular terminal or mobile receives and transmits radio frequency energy while switched on. RF interference can occur if it is used close to TV sets, radios, computers or other electric equipment.
	Road safety comes first! Do not use a hand-held cellular terminal or mobile when driving a vehicle, unless it is securely mounted in a holder for hands free operation. Before making a call with a hand-held terminal or mobile, park the vehicle.
	<p>GSM cellular terminals or mobiles operate over radio frequency signals and cellular networks and cannot be guaranteed to connect in all conditions, especially with a mobile fee or an invalid SIM card. While you are in this condition and need emergent help, please remember to use emergency calls. In order to make or receive calls, the cellular terminal or mobile must be switched on and in a service area with adequate cellular signal strength.</p> <p>Some networks do not allow for emergency call if certain network services or phone features are in use (e.g. lock functions, fixed dialing etc.). You may have to deactivate those features before you can make an emergency call.</p> <p>Also, some networks require that a valid SIM card be properly inserted in the cellular terminal or mobile.</p>

**Contact us:**

**Shanghai SIMCom Wireless Solutions Ltd.**

Add: SIM Technology Building, No.633, Jinzhong Road, Changning District, Shanghai P.R. China  
200335

Tel: +86 21 3235 3300

Fax: +86 21 3235 3020

URL: [www.simcomm2m.com](http://www.simcomm2m.com)

SIMCOM CONFIDENTIAL FILE